

PFS154 8bit MTP Type IO Controller Datasheet

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Revision History:

Revision	Date	Description
0.01	2017/11/27	1 st version
0.02	2018/01/23	 Amend the address and phone number of PADAUK Technology Co.,Ltd. Amend Section 1.2: System Features Amend Section 1.3: CPU Features Amend Chapter 3: Pin Definition and Functional Description: PA5 Amend Table 4: Recommend values of C1 and C2 for crystal and resonator oscillators Amend Section 5.4.5: System Clock and LVR levels Amend Section 5.7: Interrupt Controller Amend Section 5.8.1 Power-Save mode Amend Section 5.8.2 Power-Down mode Amend Section 5.8.3 Wake-up Amend Section 5.12.2 Using the comparator Amend Section 5.12.3 Using the comparator and band-gap 1.20V
1.03	2018/11/13	 Amend Section 5.12.3 Using the Comparator and band-gap 1.20V Amend Section 1.1: Special Features Open 32KHz EOSC mode Amend Section 5.4.6: System Clock Switching Amend Section 5.4.6: System Clock Switching Amend Section 5.8.1 Power-Save mode Amend Table 6: Differences in wake-up sources between Power-Save mode and Power-Down mode Amend Fig. 9: Hardware diagram of comparator Amend Section 5.14:11-bit PWM generation Amend Fig. 17: Hardware Diagram of 11-bit PWM Generator 0 (PWMG0) Amend Section 6.17: MISC Register Amend Section 6.29: PWMG0 Scalar Register Amend Section 6.31: PWMG0 Counter Upper Bound Low Register Amend Section 6.37: PWMG1 Counter Upper Bound Low Register Amend Section 6.41: PWMG2 Scalar Register Amend Section 6.43: PWMG2 Counter Upper Bound Low Register Amend Section 9.29 BIT definition to Section 7.10 Updated the link in Section 9.1 Amend Section 9.2.1: IO pin usage and setting Amend Section 9.2.5: TIMER time out



Major Differences between PMS154B/C and PFS154

Item	Function	PMS154B	PMS154C	PFS154
1	Operating voltage range	2.2V~5.5V	1.8V~5.5V	2.0V~5.5V
2	11-bit PWM	One Set: PWMG0	Three Sets: PWMG0, PWMG1 & PWMG2	Three Sets: PWMG0, PWMG1 & PWMG2



1. Features

1.1. Special Features

- Not supposed to use in AC RC step-down powered or high EFT requirement applications.
 PADAUK assumes no liability if such kind of applications can not pass the safety regulation tests.
- ◆ Operating temperature range: -20°C ~ 70°C

1.2. System Features

- ◆ 2KW MTP program memory (programming cycle at least 1,000 times)
- 128 Bytes data RAM
- ◆ One hardware 16-bit timer
- ◆ Two hardware 8-bit timer with PWM generators
- ◆ Three hardware 11-bit PWM generators
- Provide one hardware comparator
- ◆ 14 IO pins with optional pull-high resistor
- Three different IO driving capability groups to meet different application requirement
- ◆ Optional IO driving capability for each port: normal drive and low drive
- Every IO pin can be configured to enable wake-up function
- Built-in half VDD bias voltage generator to provide maximum 4x9 dots LCD display
- ◆ Clock sources: IHRC, ILRC & EOSC(XTAL mode)
- ◆ For every wake-up enabled IO, two optional wake-up speed are supported: normal and fast
- ◆ Eight levels of LVR: 4.0V, 3.5V, 3.0V, 2.75V, 2.5V, 2.2V, 2.0V, 1.8V
- Two external interrupt pins

1.3. CPU Features

- One processing unit operating mode
- 82 powerful instructions
- Most instructions are 1T execution cycle
- Programmable stack pointer and adjustable stack level
- Direct and indirect addressing modes for data access. Data memories are available for use as an index pointer of Indirect addressing mode
- IO space and memory space are independent

1.4. Package Information

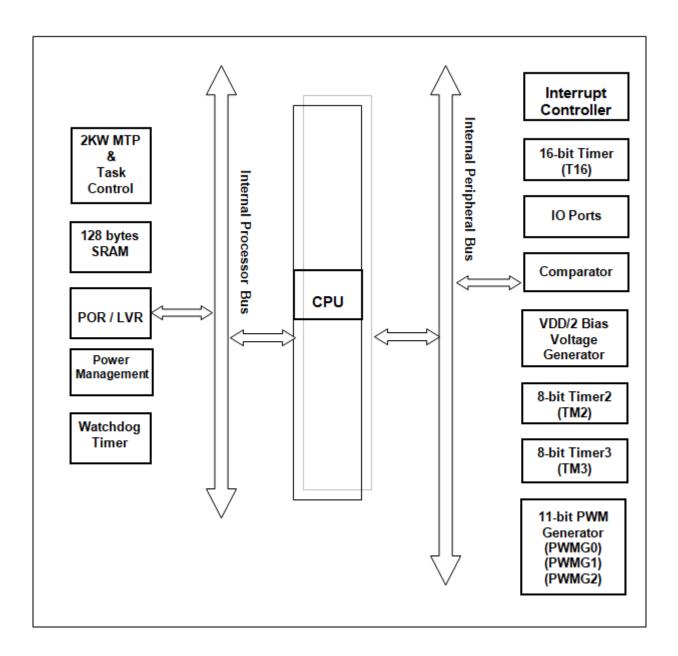
PFS154-U06: SOT23-6 (60mil)
 PFS154-S08: SOP8 (150mil)
 PFS154-M10: MSOP10 (118mil)
 PFS154-S14: SOP14 (150mil)
 PFS154-D16: DIP16 (300mil)

©PFS154-1J16A: QFN3*3-16pin (0.5pitch)



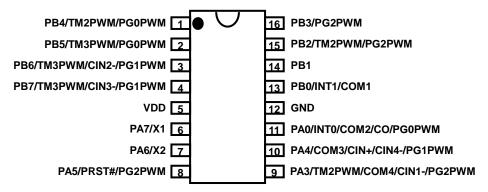
2. General Description and Block Diagram

The PFS154 is an IO-Type, fully static, MTP-based controller; it employs RISC architecture and most the instructions are executed in one cycle except that few instructions are two cycles that handle indirect memory access. 2KW MTP program memory and 128 bytes data SRAM are inside, one hardware 16-bit timer, two hardware 8-bit timers with PWM generation (Timer2, Timer3) and Three hardware 11-bit timers with PWM generation (PWMG0,1,2) is also included, PFS154 also supports one hardware comparator and VDD/2 bias voltage generator for LCD display application.

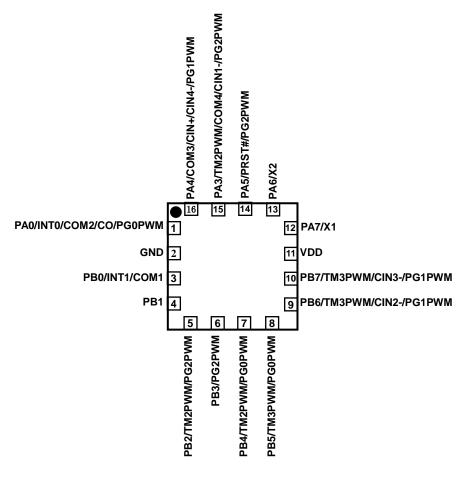




3. Pin Definition and Functional Description

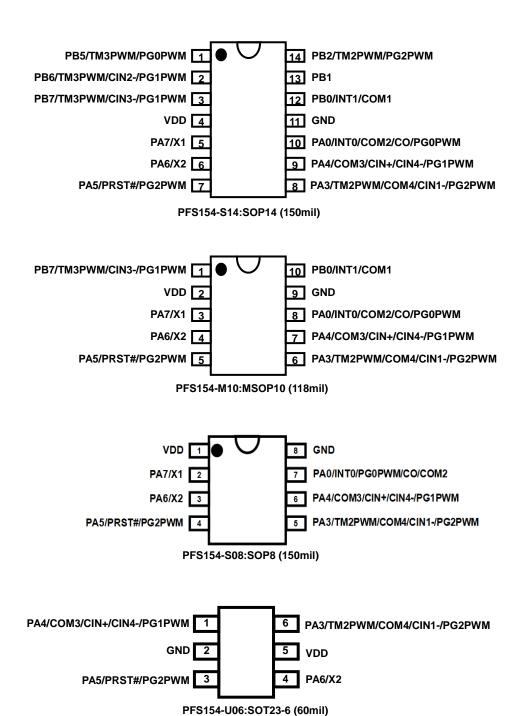


PFS154-S16: SOP16 (150mil) PFS154-D16: DIP16 (300mil)



PFS154-1J16A: QFN3*3-16pin (0.5pitch)





(Warning: PFS154-U06 pin definition is different from PMS154C-U06)



Pin Name	Pin & Buffer Type	Description
PA7 / X1	IO ST / CMOS / Analog	This pin can be used as: (1) Bit 7 of port A. It can be configured as digital input or two-state output ,with pull-up resistor by software independently (2) X1 when crystal oscillator is used When this pin is configured as crystal oscillator function, please use bit 7 of register <i>padier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 7 of <i>padier</i> register is "0".
PA6 / X2	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 6 of port A. It can be configured as digital input or two-state output, with pull-up resistor by software independently. (2) X2 when crystal oscillator is used. When this pin is configured as crystal oscillator function, please use bit 6 of register <i>padier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 6 of <i>padier</i> register is "0".
PA5 / PRST# / PG2PWM	IO ST / CMOS	 This pin can be used as: (1) Bit 5 of port A. It can be configured as digital input or open drain output, with pull-up resistor by software independently. (2) Hardware reset. (3) Output of 11-bit PWM generator PWMG2. (ICE does NOT Support.) This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 5 of <i>padier</i> register is "0". Please put 33Ω resistor in series to have high noise immunity when this pin is in input mode.
PA4 / COM3 / CIN+ / CIN4- / PG1PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 4 of port A. It can be configured as digital input or two-state output, with pull-up resistor by software independently. (2) COM3 to provide (1/2 VDD) for LCD display (3) Plus input source of comparator. (4) Minus input source 4 of comparator. (5) Output of 11-bit PWM generator PWMG2 When this pin is configured as analog input, please use bit 4 of register <i>padier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 4 of <i>padier</i> register is "0".



Pin Name	Pin & Buffer Type	Description
PA3 / TM2PWM / COM4 / CIN1- / PG2PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 3 of port A. It can be configured as digital input or two-state output, with pull-up resistor by software independently. (2) Minus input source 1 of comparator. (3) Output of 8-bit Timer2 (TM2) (4) COM4 to provide (1/2 V_{DD}) for LCD display (5) Output of 11-bit PWM generator PWMG2 When this pin is configured as analog input, please use bit 3 of register <i>padier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 3 of <i>padier</i> register is "0".
PA0 / INT0 / CO / COM2 / PG0PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 0 of port A. It can be configured as digital input or two-state output, with pull-up resistor by software independently. (2) External interrupt line 0. Both rising edge and falling edge are accepted to request interrupt service. (3) Output of comparator (4) Output of 11-bit PWM generator PWMG0 (5) COM2 to provide (1/2 V_{DD}) for LCD display When this pin is configured as analog input, please use bit 0 of register <i>padier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 0 of <i>padier</i> register is "0".
PB7 / TM3PWM / CIN3- / PG1PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 7 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Minus input source 3 of comparator. (3) Output of 8-bit timer Timer3 (TM3) (4) Output of 11-bit PWM generator PWMG1 When this pin is configured as analog input, please use bit 7 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 7 of <i>pbdier</i> register is "0".



Pin Name	Pin & Buffer Type	Description
PB6 / TM3PWM / CIN2- / PG1PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 6 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Minus input source 2 of comparator. (3) Output of 8-bit timer Timer3 (TM3) (4) Output of 11-bit PWM generator PWMG1 When this pin is configured as analog input, please use bit 6 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 6 of <i>pbdier</i> register is "0".
PB5 / TM3PWM / PG0PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 5 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Output of 8-bit timer Timer3 (TM3) (3) Output of 11-bit PWM generator PWMG0 When this pin is configured as analog input, please use bit 5 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 5 of <i>pbdier</i> register is "0".
PB4 / TM2PWM / PG0PWM	IO ST / CMOS / Analog	This pin can be used as: (1) Bit 4 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Output of 8-bit timer Timer2 (TM2) (3) Output of 11-bit PWM generator PWMG0 When this pin is configured as analog input, please use bit 4 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 4 of <i>pbdier</i> register is "0".
PB3 / PG2PWM	IO ST / CMOS /	This pin can be used as: (1) Bit 3 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Output of 11-bit PWM generator PWMG2 When this pin is configured as analog input, please use bit 3 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 3 of <i>pbdier</i> register is "0".



Pin Name	Pin & Buffer Type	Description			
PB2 / TM2PWM / PG2PWM	IO ST / CMOS / Analog	 This pin can be used as: (1) Bit 2 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) Output of 8-bit timer Timer2 (TM2) (3) Output of 11-bit PWM generator PWMG2 When this pin is configured as analog input, please use bit 2 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 2 of <i>pbdier</i> register is "0". 			
PB1 IO ST / CMOS / Analog		This pin can be used as: (1) Bit 1 of port B. It can be configured as digital input or two-state output with, pull-up resistor by software independently. When this pin is configured as analog input, please use bit 1 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 1 of <i>pbdier</i> register is "0".			
PB0 / ST / CMOS / Analog		 This pin can be used as: (1) Bit 0 of port A. It can be configured as digital input or two-state output with, pull-up resistor by software independently. (2) External interrupt line 1. Both rising edge and falling edge are accepted to request interrupt service. (3) COM1 to provide (1/2 V_{DD}) for LCD display When this pin is configured as analog input, please use bit 0 of register <i>pbdier</i> to disable the digital input to prevent current leakage. This pin can be used to wake-up system during sleep mode; however, wake-up function is also disabled if bit 0 of <i>pbdier</i> register is "0". 			
VDD		Positive power			
GND Ground					
Notes: IO: Input/Output; ST: Schmitt Trigger input; Analog: Analog input pin; CMOS: CMOS voltage level					



4. Device Characteristics

4.1. DC/AC Characteristics

All data are acquired under the conditions of V_{DD} =3.3V, f_{SYS} =2MHz unless noted.

Symbol	Description	Min	Тур	Max	Unit	Conditions(Ta=25°C)			
V_{DD}	Operating Voltage	2.0*		5.5	V	* Subject to LVR tolerance			
LVR%	Low Voltage Reset tolerance	-5		5	%				
System clock (CLK)* = IHRC/2 IHRC/4 IHRC/8 ILRC		0 0 0	70K	8M 4M 2M	Hz	$V_{DD} \ge 3.5V$ $V_{DD} \ge 2.5V$ $V_{DD} \ge 2.0V$ $V_{DD} = 3V$			
V _{POR}	Power On Reset Voltage	1.9	2.0	2.1	V	VBD 31			
I _{OP}	Operating Current		0.3 12 10		mA uA uA	f _{SYS} =IHRC/16=1MIPS@3V f _{SYS} =ILRC=70KHz@3V f _{SYS} =EOSC=32KHz@3V			
I _{PD}	Power Down Current (by stopsys command)		0.5		uA	f_{SYS} = 0Hz, V_{DD} =3.3V			
I _{PS}	Power Save Current (by stopexe command) *Disable IHRC		5		uA	V _{DD} =3.3V			
V_{IL}	Input low voltage for IO lines	0		0.1 V _{DD}	V				
V _{IH}	Input high voltage for IO lines	$0.8 V_{DD}$ $0.7 V_{DD}$		V_{DD}	V	PA5 Other IO			
	IO lines sink current (normal)								
	*PA0,PA3,PA4,PB2,PB5,PB6		10						
	*PA6,PA7,PB0,PB1,PB3,PB4,PB7		6		mΑ	$V_{DD}=3.3V, V_{OL}=0.33V$			
I_{OL}	*PA5		5						
	IO lines sink current (low)								
	*PA5		5		mA	V_{DD} =3.3V, V_{OL} =0.33V			
	*Others		2			The state of the s			
I _{OH}	IO lines drive current (normal)		-5		mA	V_{DD} =3.3V, V_{OH} =2.97V			
	IO lines drive current (low)	_	-1.6			55 , OH =			
V _{IN}	Input voltage	-0.3		$V_{DD} + 0.3$	V				
I _{INJ (PIN)}	Injected current on pin			1	mA	$V_{DD} + 0.3 \ge V_{IN} \ge -0.3$			
R _{PH}	Pull-high Resistance		200		ΚΩ	V _{DD} =3.3V			
f _{IHRC}	Frequency of IHRC after calibration *	15.84* 15.20* 13.60*	16*	16.16* 16.80* 18.40*	MHz	V_{DD} =5V, Ta=25°C V_{DD} =2.2V~5.5V, -20°C <ta<70°c* V_{DD} =2.0V~5.5V, -20°C <ta<70°c*< td=""></ta<70°c*<></ta<70°c* 			
t _{INT}	Interrupt pulse width	30			ns	$V_{DD} = 3.3V$			
V _{DR}	RAM data retention voltage*	1.5			V	In power-down mode			



Symbol	Description	Min	Тур	Max	Unit	Conditions(Ta=25°C)
			8192		-	misc[1:0]=00 (default)
_	West last for a second		16384			misc[1:0]=01
t _{WDT}	Watchdog timeout period		65536		T_ILRC	misc[1:0]=10
			262144			misc[1:0]=11
	System boot-up period from power-on for Normal boot-up		47		ms	
t _{SBP}	System boot-up period from power-on for Fast boot-up		780		us	1@ V _{DD} =5V
	Wake-up time period for fast wake-up		45		T	Where T _{ILRC} is the time
t _{WUP}	Wake-up time period for normal wake-up		3000		T _{ILRC}	period of ILRC
t _{RST}	External reset pulse width	120			us	
CPos	Comparator offset*	-	±10	±20	mV	
CPcm	Comparator input common mode*	0		V _{DD} -1.5	V	
CPspt	Comparator response time**		100	500	ns	Both rising and falling
CPmc	Stable time to change comparator mode		2.5	7.5	us	
CPcs	Comparator current consumption		20		uA	$V_{DD} = 3.3V$

^{*}These parameters are for design reference, not tested for every chip.

4.2. Absolute Maximum Ratings

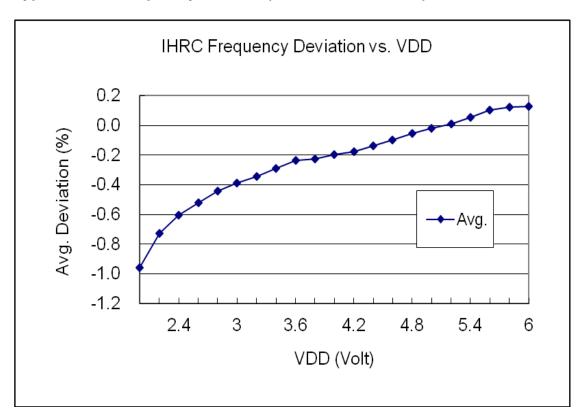
*If V_{DD} is over the maximum rating, it may lead to a permanent damage of IC.

Input Voltage -0.3V ~ V_{DD} + 0.3V

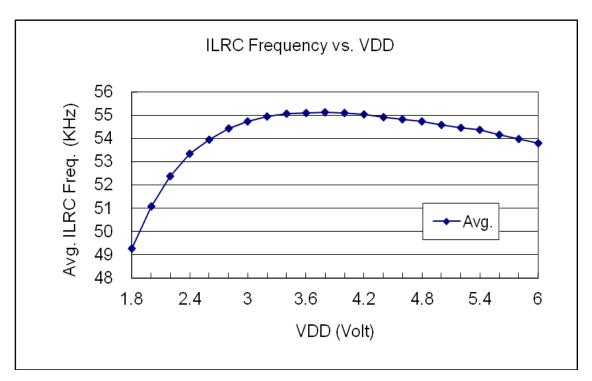
• Operating Temperature -20°C ~ 70°C

Storage Temperature-50°C ~ 125°C

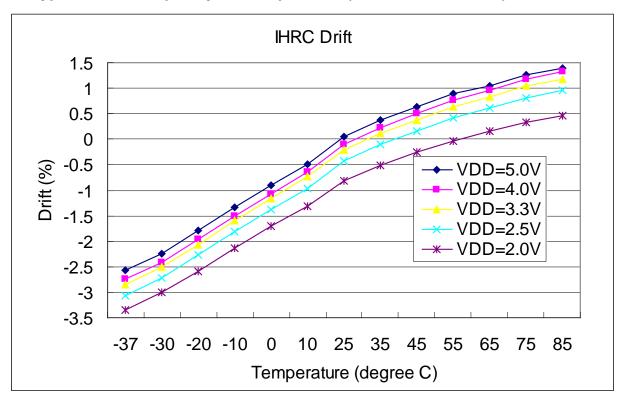
4.3. Typical IHRC Frequency vs. VDD (calibrated to 16MHz)



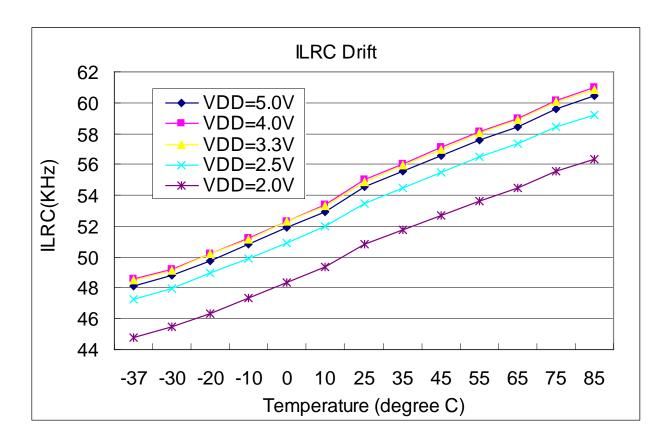
4.4. Typical ILRC Frequency vs. VDD



4.5. Typical IHRC Frequency vs. Temperature (calibrated to 16MHz)



4.6. Typical ILRC Frequency vs. Temperature

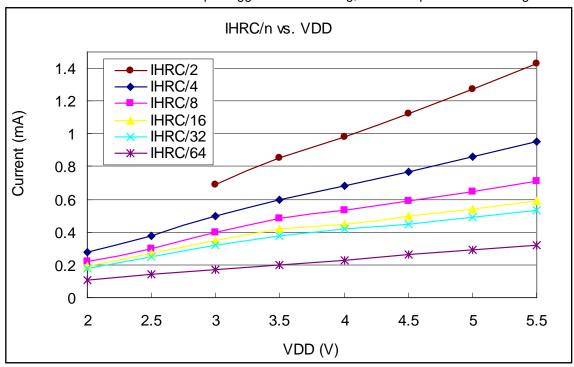




4.7. Typical Operating Current vs. VDD and CLK=IHRC/n

Conditions: ON: IHRC, Band-gap, LVR; OFF: T16 modules, ILRC modules;

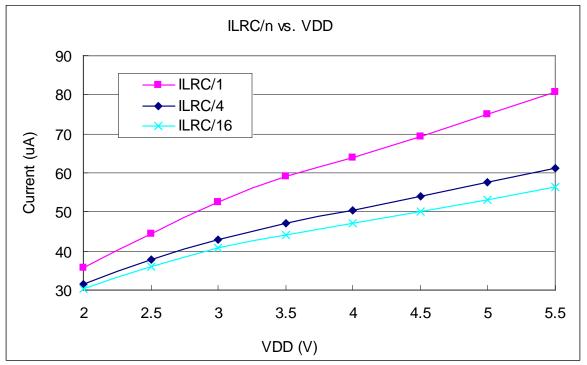
IO: PA0:0.5Hz output toggle and no loading, others: input and no floating



4.8. Typical Operating Current vs. VDD and CLK=ILRC/n

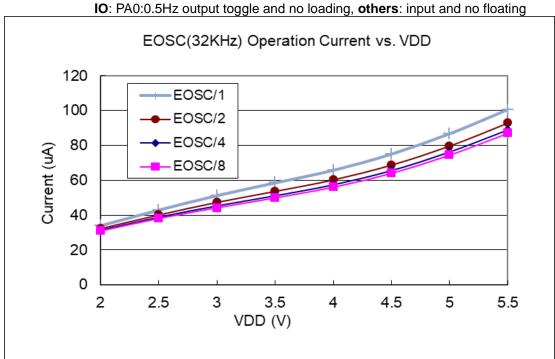
Conditions: ON: ILRC, Band-gap, LVR; OFF: T16 modules, IHRC modules;

IO: PA0:0.5Hz output toggle and no loading, others: input and no floating



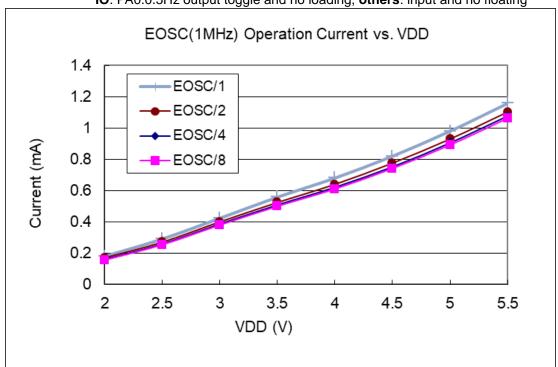
4.9. Typical Operating Current vs. VDD and CLK=32KHz EOSC / n

Conditions: **ON**: EOSC, Band-gap, LVR; **OFF**: T16 modules, IHRC, ILRC modules;



4.10. Typical Operating Current vs. VDD and CLK=1MHz EOSC / n

Conditions: **ON**: EOSC, Band-gap, LVR; **OFF**: T16 modules, IHRC, ILRC modules; **IO**: PA0:0.5Hz output toggle and no loading, **others**: input and no floating

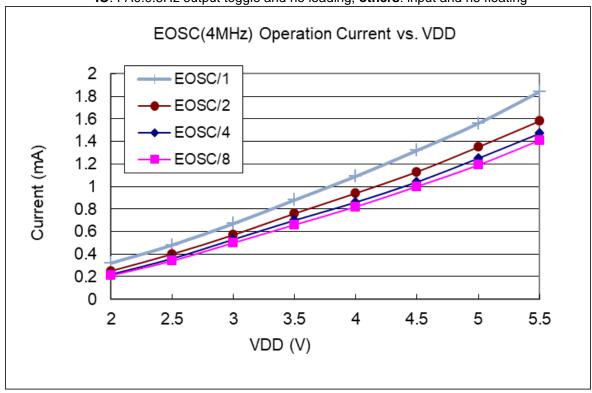




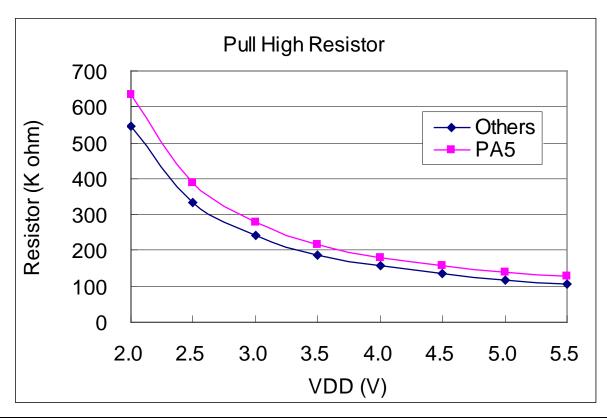
4.11. Typical Operating Current vs. VDD and CLK=4MHz EOSC / n

 $\textbf{Conditions: ON:} \ \textbf{EOSC}, \ \textbf{Band-gap}, \ \textbf{LVR; OFF:} \ \textbf{T16 modules}, \ \textbf{IHRC}, \ \textbf{ILRC modules};$

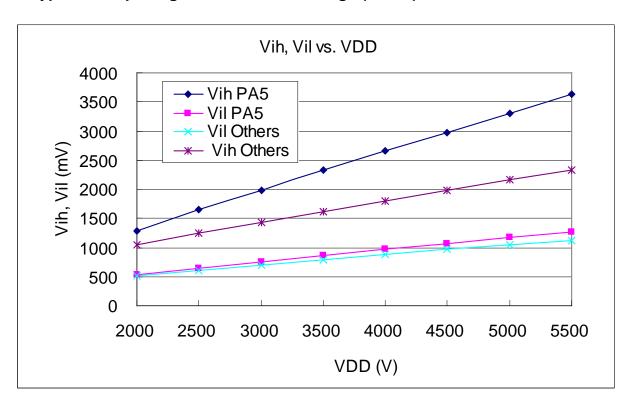
IO: PA0:0.5Hz output toggle and no loading, others: input and no floating



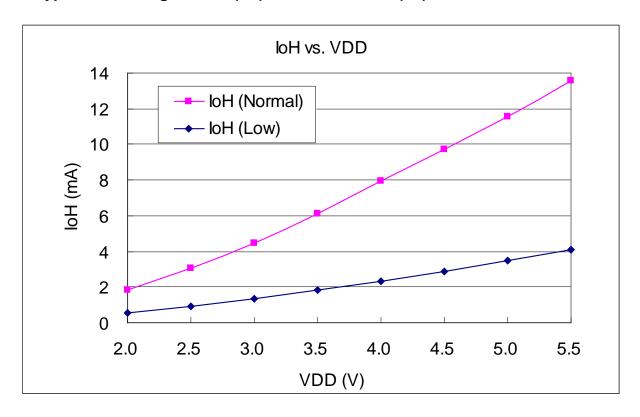
4.12. Typical IO pull high resistance



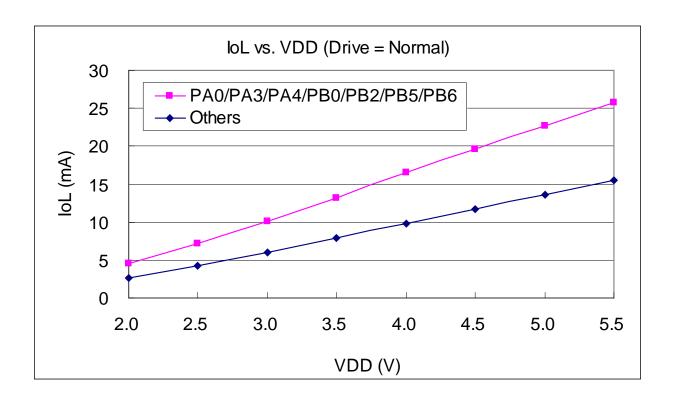
4.13. Typical IO input high/low threshold voltage (V_{IH}/V_{IL})

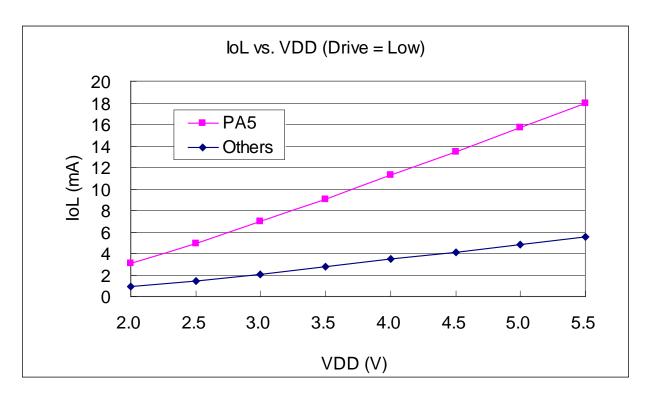


4.14. Typical IO driving current (I_{OH}) and sink current (I_{OL})



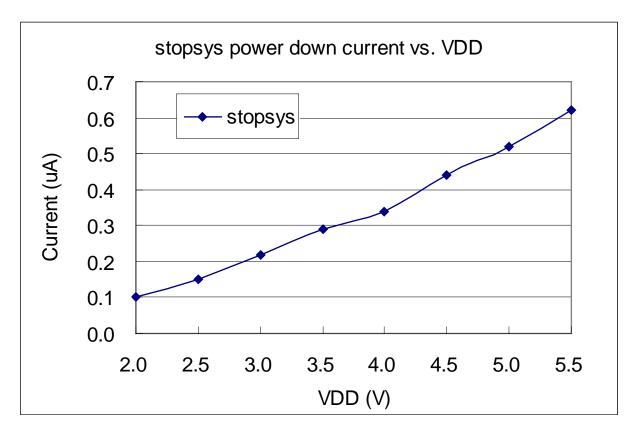


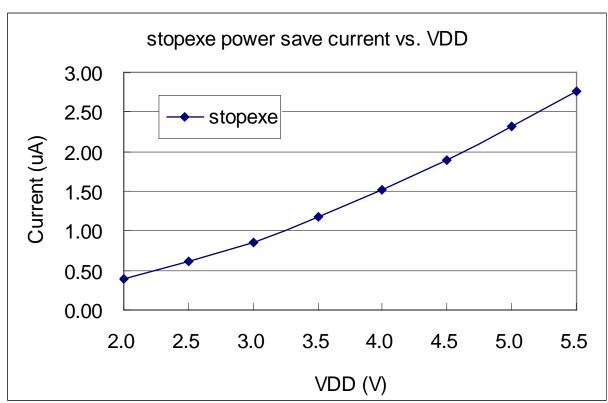






4.15. Typical power down current (IPD) and power save current (IPS)







5. Functional Description

5.1. Program Memory – MTP

The MTP (Multiple Time Programmable) program memory is used to store the program instructions to be executed. The MTP program memory may contains the data, tables and interrupt entry. After reset, the initial address 0x000 is reserved for system using, so the program will start from 0x001 which is GOTO FPPA0 instruction usually. The interrupt entry is 0x010 if used, the last 32 addresses are reserved for system using, like checksum, serial number, etc. The MTP program memory for PFS154 is 2KW that is partitioned as Table 1. The MTP memory from address 0x7E0 to 0x7FF is for system using, address space from 0x000 to 0x00F and from 0x011 to 0x7DF is user program space.

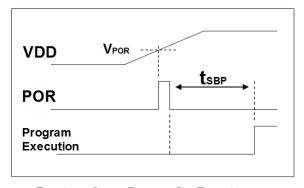
Address	Function			
0x000	GOTO FPPA0 instruction			
0x001	User program			
•	•			
0x00F	User program			
0x010	Interrupt entry address			
0x011	User program			
•	•			
0x7DF	User program			
0x7E0	System Using			
•	•			
0x7FF	System Using			

Table 1: Program Memory Organization

5.2. Boot-Up

POR (Power-On-Reset) is used to reset PFS154 when power up. The boot up time can be optional fast or normal. Time for fast boot-up is about 45 ILRC clock cycles whereas 3000 ILRC clock cycles for normal boot-up. Customer must ensure the stability of supply voltage after power up no matter which option is chosen, the power up sequence is shown in the Fig. 1 and t_{SBP} is the boot up time.

Please noted, during Power-On-Reset, the V_{DD} must go higher than V_{POR} to boot-up the MCU.



Boot up from Power-On Reset

Fig. 1: Power Up Sequence



5.3. Data Memory - SRAM

The access of data memory can be byte or bit operation. Besides data storage, the SRAM data memory is also served as data pointer of indirect access method and the stack memory.

The stack memory is defined in the data memory. The stack pointer is defined in the stack pointer register; the depth of stack memory of each processing unit is defined by the user. The arrangement of stack memory fully flexible and can be dynamically adjusted by the user.

For indirect memory access mechanism, the data memory is used as the data pointer to address the data byte. All the data memory could be the data pointer; it's quite flexible and useful to do the indirect memory access. All the 128 bytes data memory of PFS154 can be accessed by indirect access mechanism.

5.4. Oscillator and clock

There are three oscillator circuits provided by PFS154: external crystal oscillator (EOSC), internal high RC oscillator (IHRC) and internal low RC oscillator (ILRC), and these three oscillators are enabled or disabled by registers eoscr.7, clkmd.4 and clkmd.2 independently. User can choose one of these three oscillators as system clock source and use *clkmd* register to target the desired frequency as system clock to meet different applications.

Oscillator Module	Enable / Disable	
EOSC	eoscr.7	
IHRC	clkmd.4	
ILRC	clkmd.2	

Table2: Three Oscillator Circuits provided by PFS154

5.4.1 Internal High RC oscillator and Internal Low RC oscillator

The frequency of IHRC can be calibrated to eliminate process variation by *ihrcr* register; normally it is calibrated to 16MHz. Please refer to the measurement chart for IHRC frequency verse V_{DD} and IHRC frequency verse temperature.

The frequency of ILRC will vary by process, supply voltage and temperature, please refer to DC specification and do not use for accurate timing application.

5.4.2 IHRC calibration

The IHRC frequency may be different chip by chip due to manufacturing variation, PFS154 provide the IHRC frequency calibration to eliminate this variation, and this function can be selected when compiling user's program and the command will be inserted into user's program automatically. The calibration command is shown as below:

.ADJUST_IC SYSCLK=IHRC/(p1), IHRC=(p2)MHz, V_{DD} =(p3)V Where.

p1=2, 4, 8, 16, 32; In order to provide different system clock.

p2=16 ~ 18; In order to calibrate the chip to different frequency, 16MHz is the usually one.

p3=1.8 ~ 5.5; In order to calibrate the chip under different supply voltage.



5.4.3 IHRC Frequency Calibration and System Clock

During compiling the user program, the options for IHRC calibration and system clock are shown as Table 3:

SYSCLK	CLKMD	IHRCR	Description	
o Set IHRC / 2	= 34h (IHRC / 2)	Calibrated	IHRC calibrated to 16MHz, CLK=8MHz (IHRC/2)	
o Set IHRC / 4	= 14h (IHRC / 4)	Calibrated	IHRC calibrated to 16MHz, CLK=4MHz (IHRC/4)	
o Set IHRC / 8	= 3Ch (IHRC / 8)	Calibrated	IHRC calibrated to 16MHz, CLK=2MHz (IHRC/8)	
o Set IHRC / 16	= 1Ch (IHRC / 16)	Calibrated	IHRC calibrated to 16MHz, CLK=1MHz (IHRC/16)	
o Set IHRC / 32	= 7Ch (IHRC / 32)	Calibrated	IHRC calibrated to 16MHz, CLK=0.5MHz (IHRC/32)	
∘ Set ILRC	= E4h (ILRC / 1)	Calibrated	IHRC calibrated to 16MHz, CLK=ILRC	
o Disable	No change	No Change	IHRC not calibrated, CLK not changed, Band-gap OFF	

Table 3: Options for IHRC Frequency Calibration

Usually, .ADJUST_IC will be the first command after boot up, in order to set the target operating frequency whenever stating the system. The program code for IHRC frequency calibration is executed only one time that occurs in writing the codes into MTP memory; after then, it will not be executed again. If the different option for IHRC calibration is chosen, the system status is also different after boot. The following shows the status of PFS154 for different option:

(1) ADJUST_IC SYSCLK=IHRC/2, IHRC=16MHz, VDD=5V

After boot, CLKMD = 0x34:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- ◆ System CLK = IHRC/2 = 8MHz
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(2) ADJUST_IC SYSCLK=IHRC/4, IHRC=16MHz, VDD=3.3V

After boot, CLKMD = 0x14:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=3.3V and IHRC module is enabled
- ◆ System CLK = IHRC/4 = 4MHz
- ◆ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(3) ADJUST_IC SYSCLK=IHRC/8, IHRC=16MHz, VDD=2.5V

After boot, CLKMD = 0x3C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=2.5V and IHRC module is enabled
- ♦ System CLK = IHRC/8 = 2MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(4) ADJUST_IC SYSCLK=IHRC/16, IHRC=16MHz, VDD=2.2V

After boot, CLKMD = 0x1C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=2.2V and IHRC module is enabled
- ◆ System CLK = IHRC/16 = 1MHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(5) ADJUST_IC SYSCLK=IHRC/32, IHRC=16MHz, V_{DD}=5V

After boot, CLKMD = 0x7C:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is enabled
- ◆ System CLK = IHRC/32 = 500KHz
- Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode



(6) ADJUST_IC SYSCLK=ILRC, IHRC=16MHz, VDD=5V

After boot, CLKMD = 0xE4:

- ♦ IHRC frequency is calibrated to 16MHz@V_{DD}=5V and IHRC module is disabled
- ◆ System CLK = ILRC
- ♦ Watchdog timer is disabled, ILRC is enabled, PA5 is in input mode

(7) .ADJUST_IC DISABLE

After boot, CLKMD is not changed (Do nothing):

- ♦ IHRC is not calibrated
- ◆ System CLK = ILRC or IHRC/64 (by Boot-up Time)
- Watchdog timer is enabled, ILRC is enabled, PA5 is in input mode

5.4.4 External Crystal Oscillator

If crystal oscillator is used, a crystal or resonator is required between X1 and X2. Fig. 2 shows the hardware connection under this application; the range of operating frequency of crystal oscillator can be from 32 KHz to 4MHz, depending on the crystal placed on; higher frequency oscillator than 4MHz is NOT supported.

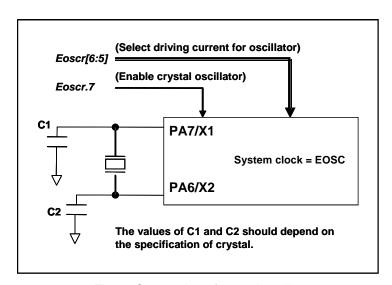


Fig. 2: Connection of crystal oscillator

Besides crystal, external capacitor and options of PFS154 should be fine tuned in *eoscr* (0x0a) register to have good sinusoidal waveform. The *eoscr*.7 is used to enable crystal oscillator module, *eoscr*.6 and *eoscr*.5 are used to set the different driving current to meet the requirement of different frequency of crystal oscillator:

- eoscr.[6:5]=01 : Low driving capability, for lower frequency, ex: 32KHz crystal oscillator
- ◆ eoscr.[6:5]=10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator
- eoscr.[6:5]=11: High driving capability, for higher frequency, ex: 4MHz crystal oscillator

Table 4 shows the recommended values of C1 and C2 for different crystal oscillator; the measured start-up time under its corresponding conditions is also shown. Since the crystal or resonator had its own characteristic, the capacitors and start-up time may be slightly different for different type of crystal or resonator, please refer to its specification for proper values of C1 and C2.

Frequency	C1	C2	Measured Start-up time	Conditions
4MHz	4.7pF	4.7pF	6ms	(eoscr[6:5]=11)
1MHz	10pF	10pF	11ms	(eoscr[6:5]=10)
32KHz	22pF	22pF	450ms	(eoscr[6:5]=01)

Table 4: Recommend values of C1 and C2 for crystal and resonator oscillators

When using the crystal oscillator, user must pay attention to the stable time of oscillator after enabling it, the stable time of oscillator will depend on frequency, crystal type, external capacitor and supply voltage. Before switching the system to the crystal oscillator, user must make sure the oscillator is stable; the reference program is shown as below:

```
void
        FPPA0 (void)
{
       .ADJUST_IC
                      SYSCLK=IHRC/16, IHRC=16MHz, V<sub>DD</sub>=5V
                                         // EOSCR = 0b110_00000
       $EOSCR Enable, 4Mhz;
       $ T16M EOSC, /1,
                                         // while T16.Bit13 0 => 1, Intrq.T16 => 1
                               BIT13;
                                          // suppose crystal osc. is stable
       WORD
                 count
                                0;
       stt16
                 count;
       Intrq.T16 =
       while (! Intrq.T16) NULL;
                                         // count fm 0x0000 to 0x2000, then trigger INTRQ.T16
       clkmd = 0xB4;
                                         // switch system clock to EOSC
       clkmd.4 = 0;
                                          //disable IHRC
}
```

Please notice that the crystal oscillator should be fully turned off before entering the power-down mode, in order to avoid unexpected wakeup event.

5.4.5 System Clock and LVR levels

The clock source of system clock comes from IHRC, ILRC or EOSC, the hardware diagram of system clock in the PFS154 is shown as Fig. 3.

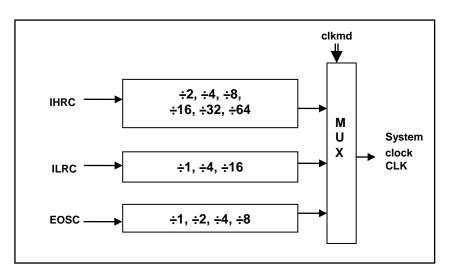


Fig. 3: Options of System Clock

User can choose different operating system clock depends on its requirement; the selected operating system clock should be combined with supply voltage and LVR level to make system stable. The LVR level will be checked during compilation, and the lowest LVR levels can be chosen for different operating frequencies. Please refer to Section 4.1.

5.4.6 System Clock Switching

After IHRC calibration, user may want to switch system clock to a new frequency or may switch system clock at any time to optimize the system performance and power consumption. Basically, the system clock of PFC154 can be switched among IHRC, ILRC and EOSC by setting the *clkmd* register at any time; system clock will be the new one after writing to *clkmd* register immediately. Please notice that the original clock module can NOT be turned off at the same time as writing command to *clkmd* register. The examples are shown as below and more information about clock switching, please refer to the "Help" -> "Application Note" -> "IC Introduction" -> "Register Introduction" -> CLKMD".

Case 1: Switching system clock from ILRC to IHRC/2

```
... // system clock is ILRC

CLKMD = 0x34; // switch to IHRC/2 , ILRC <u>CAN NOT</u> be disabled here

CLKMD.2 = 0; // ILRC <u>CAN</u> be disabled at this time
...
```

Case 2: Switching system clock from ILRC to EOSC

```
... // system clock is ILRC

CLKMD = 0xA6; // switch to IHRC , ILRC CAN NOT be disabled here

CLKMD.2 = 0; // ILRC CAN be disabled at this time

...
```



turn off ILRC oscillator at the same time

Case 3: Switching system clock from IHRC/2 to ILRC system clock is IHRC/2 switch to ILRC , IHRC CAN NOT be disabled here CLKMD 0xF4; // CLKMD.4 0; // IHRC CAN be disabled at this time Case 4: Switching system clock from IHRC/2 to EOSC system clock is IHRC/2 // switch to EOSC, IHRC CAN NOT be disabled here CLKMD 0xB0; CLKMD.4 0; // IHRC CAN be disabled at this time Case 5: Switching system clock from IHRC/2 to IHRC/4 system clock is IHRC/2, ILRC is enabled here // switch to IHRC/4 CLKMD 0x14; Case 6: System may hang if it is to switch clock and turn off original oscillator at the same time // system clock is ILRC **CLKMD** CAN NOT switch clock from ILRC to IHRC/2 and 0x30;



5.5. 16-bit Timer (Timer16)

PFS154 provide a 16-bit hardware timer (Timer16/T16) and its clock source may come from system clock (CLK), internal high RC oscillator (IHRC), internal low RC oscillator (ILRC), external crystal oscillator (EOSC), PA0 or PA4. Before sending clock to the 16-bit counter, a pre-scaling logic with divided-by-1, 4, 16 or 64 is selectable for wide range counting. The 16-bit counter performs up-counting operation only, the counter initial values can be stored from data memory by issuing the *stt16* instruction and the counting values can be loaded to data memory by issuing the *ldt16* instruction. The interrupt request from Timer16 will be triggered by the selected bit which comes from bit[15:8] of this 16-bit counter, rising edge or falling edge can be optional chosen by register *integs.4*. The hardware diagram of Timer16 is shown as Fig. 4.

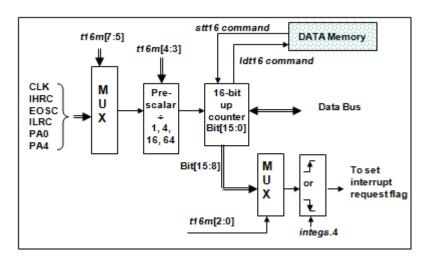


Fig. 4: Hardware diagram of Timer16

There are three parameters to define the Timer16 using; 1st parameter is used to define the clock source of Timer16, 2nd parameter is used to define the pre-scalar and the 3rd one is to define the interrupt source.

```
T16M IO_RW 0x06
$ 7~5: STOP, SYSCLK, X, PA4_F, IHRC, EOSC, ILRC, PA0_F // 1<sup>st</sup> par.
$ 4~3: /1, /4, /16, /64 // 2<sup>nd</sup> par.
$ 2~0: BIT8, BIT9, BIT10, BIT11, BIT12, BIT13, BIT14, BIT15 // 3<sup>rd</sup> par.
```

User can choose the proper parameters of T16M to meet system requirement, examples as below:

\$ T16M SYSCLK, /64, BIT15;

```
// choose (SYSCLK/64) as clock source, every 2^16 clock to set INTRQ.2=1 // if system clock SYSCLK = IHRC / 2 = 8 MHz // SYSCLK/64 = 8 MHz/64 = 8 uS, about every 524 mS to generate INTRQ.2=1
```

\$ T16M PA0, /1, BIT8;

// choose PA0 as clock source, every 2^9 to generate INTRQ.2=1 // receiving every 512 times PA0 to generate INTRQ.2=1

\$ T16M STOP:

// stop Timer16 counting



5.6. Watchdog Timer

The watchdog timer (WDT) is a counter with clock coming from ILRC. WDT can be cleared by power-on-reset or by command **wdreset** at any time. There are four different timeout periods of watchdog timer can be chosen by setting the **misc** register, it is:

- ◆ 8k ILRC clock period when misc[1:0]=00 (default)
- ◆ 16k ILRC clock period when misc[1:0]=01
- ◆ 64k ILRC clock period when misc[1:0]=10
- 256k ILRC clock period when misc[1:0]=11

The frequency of ILRC may drift a lot due to the variation of manufacture, supply voltage and temperature; user should reserve guard band for safe operation. Besides, the watchdog period will also be shorter than expected after Reset or Wakeup events. It is suggested to clear WDT by **wdreset** command after these events to ensure enough clock periods before WDT timeout.

When WDT is timeout, PFS154 will be reset to restart the program execution. The relative timing diagram of watchdog timer is shown as Fig. 5.

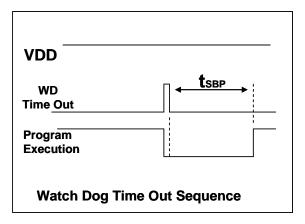


Fig. 5: Sequence of Watch Dog Time Out



5.7. Interrupt Controller

The hardware diagram of interrupt controller is shown as Fig. 6, there are total 7 interrupt sources for PFS154: PA0, PB0, Timer16, Comparator, Timer2, Timer3, PWMG0. Among them, every interrupt request line to CPU has its own corresponding interrupt control bit to enable or disable it. All the interrupt request flags are set by hardware and cleared by writing *intrq* register. When the request flags are set, it can be rising edge, falling edge or both, depending on the setting of register *integs*. All the interrupt request lines are also controlled by *engint* instruction (enable global interrupt) to enable interrupt operation and *disgint* instruction (disable global interrupt) to disable it.

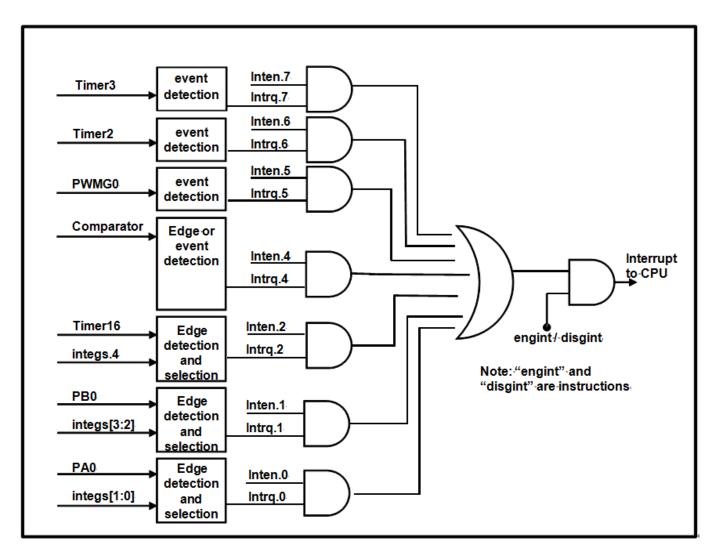


Fig. 6: Hardware diagram of Interrupt controller



The stack memory for interrupt is shared with data memory and its address is specified by stack register **sp**. Since the program counter is 16 bits width, the bit 0 of stack register **sp** should be kept 0. Moreover, user can use **pushaf/popaf** instructions to store or restore the values of **ACC** and **flag** register **to/from** stack memory. Since the stack memory is shared with data memory, the stack position and level are arranged by the compiler in Mini-C project. When defining the stack level in ASM project, users should arrange their locations carefully to prevent address conflicts.

Once the interrupt occurs, its operation will be:

- ◆ The program counter will be stored automatically to the stack memory specified by register sp.
- ♦ New sp will be updated to sp+2.
- Global interrupt will be disabled automatically.
- ◆ The next instruction will be fetched from address 0x010.

During the interrupt service routine, the interrupt source can be determined by reading the *intrq* register.

Note: Even if INTEN=0, INTRQ will be still triggered by the interrupt source.

After finishing the interrupt service routine and issuing the *reti* instruction to return back, its operation will be:

- ◆ The program counter will be restored automatically from the stack memory specified by register sp.
- New sp will be updated to sp-2.
- Global interrupt will be enabled automatically.
- ◆ The next instruction will be the original one before interrupt.

User must reserve enough stack memory for interrupt, two bytes stack memory for one level interrupt and four bytes for two levels interrupt. And so on, two bytes stack memory is for *pushaf*. For interrupt operation, the following sample program shows how to handle the interrupt, noticing that it needs four bytes stack memory to handle one level interrupt and *pushaf*.



```
void Interrupt (void)
                               // interrupt service routine
{
     PUSHAF
                              // store ALU and FLAG register
    // If INTEN.PA0 will be opened and closed dynamically,
     // user can judge whether INTEN.PA0 =1 or not.
    // Example: If (INTEN.PA0 && INTRQ.PA0) {...}
    // If INTEN.PA0 is always enable,
    // user can omit the INTEN.PA0 judgement to speed up interrupt service routine.
     If (INTRQ.PA0)
                              // Here for PA0 interrupt service routine
          INTRQ.PA0 = 0;
                             // Delete corresponding bit (take PA0 for example)
    }
    //X: INTRQ = 0;
                             // It is not recommended to use INTRQ = 0 to clear all at the end of the
                             // interrupt service routine.
                            // It may accidentally clear out the interrupts that have just occurred
                            // and are not yet processed.
    POPAF
                            // restore ALU and FLAG register
}
```



5.8. Power-Save and Power-Down

There are three operational modes defined by hardware: ON mode, Power-Save mode and Power-Down modes. ON mode is the state of normal operation with all functions ON, Power-Save mode ("stopexe") is the state to reduce operating current and CPU keeps ready to continue, Power-Down mode ("stopsys") is used to save power deeply. Therefore, Power-Save mode is used in the system which needs low operating power with wake-up occasionally and Power-Down mode is used in the system which needs power down deeply with seldom wake-up. Table 5 shows the differences in oscillator modules between Power-Save mode ("stopsys") and Power-Down mode ("stopsys").

Differences in oscillator modules between STOPSYS and STOPEXE				
	IHRC	ILRC		
STOPSYS	Stop	Stop		
STOPEXE	No Change	No Change		

Table 5: Differences in oscillator modules between STOPSYS and STOPEXE

5.8.1 Power-Save mode ("stopexe")

Using "stopexe" instruction to enter the Power-Save mode, only system clock is disabled, remaining all the oscillator modules be active. For CPU, it stops executing; however, for Timer16, counter keep counting if its clock source is not the system clock. The wake-up sources for "stopexe" can be IO-toggle or Timer16 counts to set values when the clock source of Timer16 is IHRC or ILRC modules. Wake-up from input pins can be considered as a continuation of normal execution, the detail information for Power-Save mode shown below:

- IHRC oscillator modules: No change, keep active if it was enabled
- ILRC oscillator modules: must remain enabled, need to start with ILRC when be wakening up
- System clock: Disable, therefore, CPU stops execution
- MTP memory is turned off
- Timer16, Timer2, Timer3: Stop counting if system clock is selected by clock source or the corresponding oscillator module is disabled; otherwise, it keeps counting.
- Wake-up sources: IO toggle in digital mode (PxDIER bit is 1) or Timer16 or Timer2 or Timer3.

An example shows how to use Timer16 to wake-up from "stopexe":

```
$ T16M ILRC, /1, BIT8 // Timer16 setting ...

WORD count = 0;

STT16 count;

stopexe;
```

The initial counting value of Timer16 is zero and the system will be woken up after the Timer16 counts 256 ILRC clocks.



5.8.2 Power-Down mode ("stopsys")

Power-Down mode is the state of deeply power-saving with turning off all the oscillator modules. By using the "stopsys" instruction, this chip will be put on Power-Down mode directly. The following shows the internal status of PFS154 in detail when "stopsys" command is issued:

- All the oscillator modules are turned off
- MTP memory is turned off
- The contents of SRAM and registers remain unchanged
- Wake-up sources: IO toggle in digital mode (PxDIER bit is 1)

Wake-up from input pins can be considered as a continuation of normal execution. To minimize power consumption, all the I/O pins should be carefully manipulated before entering power-down mode. The reference sample program for power down is shown as below:

```
CMKMD =
              0xF4;
                                 Change clock from IHRC to ILRC, disable watchdog timer
CLKMD.4 =
                                 disable IHRC
while (1)
{
     STOPSYS;
                            //
                                 enter power-down
    if (...) break;
                            //
                                 if wakeup happen and check OK, then return to high speed,
                                 else stay in power-down mode again.
CLKMD
                                 Change clock from ILRC to IHRC/2
              0x34;
```



5.8.3 Wake-up

After entering the Power-Down or Power-Save modes, the PFS154 can be resumed to normal operation by toggling IO pins, Timer16, Timer2 and Timer3 interrupt is available for Power-Save mode ONLY. Table 6 shows the differences in wake-up sources between STOPSYS and STOPEXE.

Differences in wake-up sources between STOPSYS and STOPEXE				
	IO Toggle	Timer Interrupt		
STOPSYS	Yes	No		
STOPEXE	Yes	Yes		

Table 6: Differences in wake-up sources between Power-Save mode and Power-Down mode

When using the IO pins to wake-up the PFS154, registers *pxdier* should be properly set to enable the wake-up function for every corresponding pin. The time for normal wake-up is about 3,000 ILRC clocks counting from wake-up event; fast wake-up can be selected to reduce the wake-up time by *misc* register, and the time for fast wake-up is about 45 ILRC clocks from IO toggling.

Suspend mode	Wake-up mode	Wake-up time (t _{WUP}) from IO toggle	
STOPEXE suspend		45 * T	
or	Fast wake-up	45 * T _{ILRC} ,	
STOPSYS suspend		Where T _{ILRC} is the time period of ILRC	
STOPEXE suspend		2000 * T	
or	Normal wake-up	3000 * T _{ILRC} ,	
STOPSYS suspend		Where T _{ILRC} is the clock period of ILRC	

Please notice that when Code Option is set to Fast boot-up, no matter which wake-up mode is selected in *misc.5*, the wake-up mode will be forced to be FAST. If Normal boot-up is selected, the wake-up mode is determined by *misc.5*.



5.9. IO Pins

Other than PA5, all the pins can be independently set into two states output or input by configuring the data registers (pa/pb), control registers (pac/pbc) and pull-high registers (paph/pbph). All these pins have Schmitt-trigger input buffer and output driver with CMOS level. When it is set to output low, the pull-up resistor is turned off automatically. If user wants to read the pin state, please notice that it should be set to input mode before reading the data port; if user reads the data port when it is set to output mode, the reading data comes from data register, NOT from IO pad. As an example, Table 7 shows the configuration table of bit 0 of port A. The hardware diagram of IO buffer is also shown as Fig. 7.

pa.0	pac.0	paph.0	Description
Χ	0	0	Input without pull-up resistor
X	0	1	Input with pull-up resistor
0	1	Х	Output low without pull-up resistor
1	1	0	Output high without pull-up resistor
1	1	1	Output high with pull-up resistor

Table 7: PA0 Configuration Table

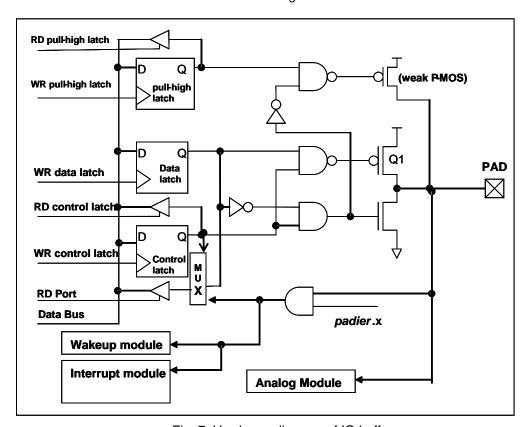


Fig. 7: Hardware diagram of IO buffer

Most IOs can be adjusted their Driving or Sinking current capability to Normal or Low by code option Drive.

Other than PA5, all the IO pins have the same structure; PA5 can be open-drain ONLY when setting to output mode (without Q1). When PFS154 put in power-down or power-save mode, every pin can be used to wake-up system by toggling its state. Therefore, those pins needed to wake-up system must be set to input mode and set the corresponding bits of registers pxdier to high. The same reason, padier.0 should be set to high when PA0 is used as external interrupt pin.

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5.10. Reset and LVR

5.10.1 Reset

There are many causes to reset the PFS154, once reset is asserted, all the registers in PFS154 will be set to default values, system should be restarted once abnormal cases happen, or by jumping program counter to address 0x0. The data memory is in uncertain state when reset comes from power-up and LVR; however, the content will be kept when reset comes from PRST# pin or WDT timeout.

5.10.2 LVR reset

By code option *LVR*, there are 8 different levels of LVR for reset: 4.0V, 3.5V, 3.0V, 2.75V, 2.5V, 2.2V, 2.0V and 1.8V, usually, user selects LVR reset level to be in conjunction with operating frequency and supply voltage.

5.11. VDD/2 Bias Voltage Generator

This function can be enabled by $\it{misc.4}$ and code option $\it{LCD2}$. To use this function, user must select $\it{PBO_A034}$ for $\it{LCD2}$ and set $\it{misc.4}$ to 1 in the program. Those pins which are defined to output VDD/2 voltage are PB0, PA0, PA4 and PA3 during input mode, being used as COM function for LCD application. If user wants to output \it{V}_{DD} , VDD/2, GND three levels voltage, the corresponding pins must be set to output-high for \it{V}_{DD} , enabling VDD/2 bias voltage with input mode for VDD/2, and output-low for GND correspondingly, Fig.8 shows how to use this function.

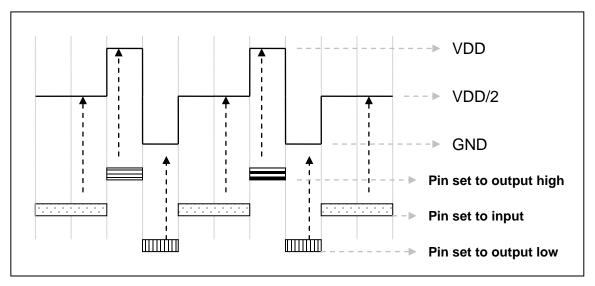


Fig. 8: Using VDD/2 bias voltage generator



5.12. Comparator

One hardware comparator is built inside the PFS154; Fig. 9 shows its hardware diagram. It can compare signals between two pins or with either internal reference voltage V_{internal R} or internal band-gap reference voltage. The two signals to be compared, one is the plus input and the other one is the minus input. For the minus input of comparator can be PA3, PA4, Internal band-gap 1.20V, PB6, PB7 or V_{internal R} selected by bit [3:1] of *gpcc* register, and the plus input of comparator can be PA4 or V_{internal R} selected by bit 0 of gpcc register. The output result can be enabled to output to PA0 directly, or sampled by Time2 clock (TM2_CLK) which comes from Timer2 module. The output can be also inversed the polarity by bit 4 of *gpcc* register. The comparator output can be used to request interrupt service.

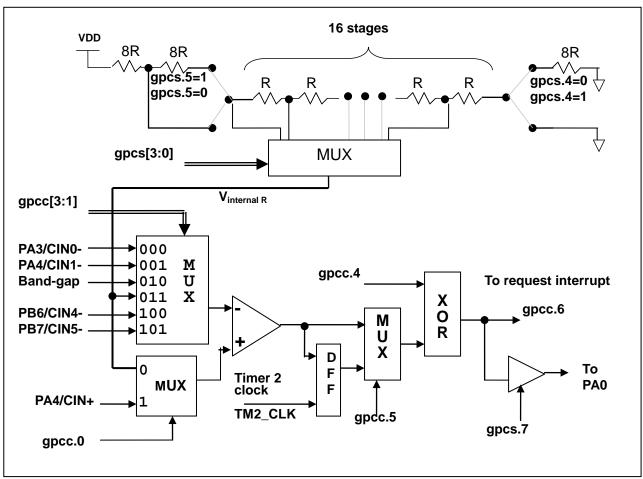


Fig. 9: Hardware diagram of comparator

5.12.1 Internal reference voltage (V_{internal R})

The internal reference voltage $V_{internal\ R}$ is built by series resistance to provide different level of reference voltage, bit 4 and bit 5 of *gpcs* register are used to select the maximum and minimum values of $V_{internal\ R}$ and bit [3:0] of *gpcs* register are used to select one of the voltage level which is deivided-by-16 from the defined maximum level to minimum level. Fig. 10 to Fig. 13 shows four conditions to have different reference voltage $V_{internal\ R}$. By setting the *gpcs* register, the internal reference voltage $V_{internal\ R}$ can be ranged from $(1/32)^*V_{DD}$ to $(3/4)^*V_{DD}$.

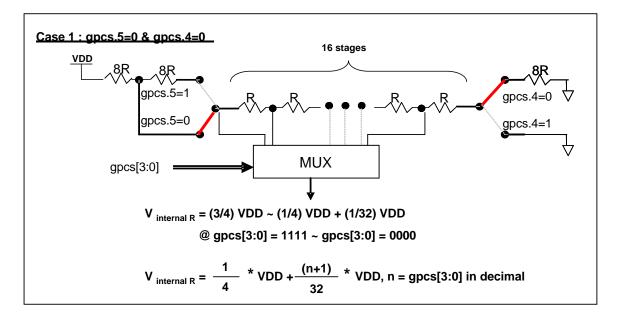


Fig. 10: V_{internal R} hardware connection if gpcs.5=0 and gpcs.4=0

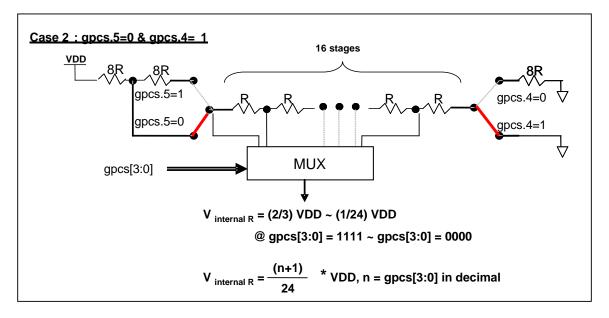


Fig. 11: V_{internal R} hardware connection if gpcs.5=0 and gpcs.4=1

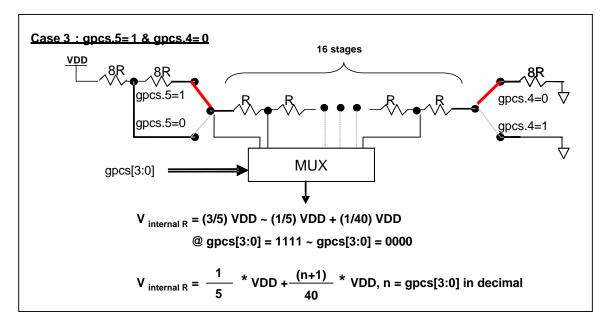


Fig. 12: V_{internal R} hardware connection if gpcs.5=1 and gpcs.4=0

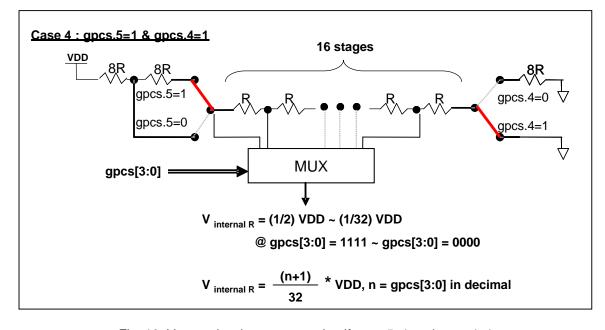


Fig. 13: V_{internal R} hardware connection if gpcs.5=1 and gpcs.4=1



5.12.2 Using the comparator

Case 1:

Choosing PA3 as minus input and $V_{internal\ R}$ with $(18/32)^*V_{DD}$ voltage level as plus input. $V_{internal\ R}$ is configured as the above Figure "gpcs[5:4] = 2b'00" and gpcs [3:0] = 4b'1001 (n=9) to have $V_{internal\ R}$ = $(1/4)^*V_{DD}$ + $[(9+1)/32]^*V_{DD}$ = $[(9+9)/32]^*V_{DD}$ = $(18/32)^*V_{DD}$.

```
= 0b1_0_00_1001;
                                        // V_{internal R} = V_{DD}^* (18/32)
gpcs
          = 0b1_0_0_0_000_0;
                                        // enable comp, - input: PA3, + input: V<sub>internal R</sub>
gpcc
padier
          = 0bxxxx_0_xx;
                                        // disable PA3 digital input to prevent leakage current
or
$ GPCS
            V_{DD}*18/32;
            Enable, N PA3, P R;
                                        //- input: N xx, + input: P R(V_{internal R})
$ GPCC
PADIER = 0bxxxx\_0\_xxx;
```

Case 2:

Choosing $V_{internal\ R}$ as minus input with $(22/40)^*V_{DD}$ voltage level and PA4 as plus input, the comparator result will be inversed and then output to PA0. $V_{internal\ R}$ is configured as the above Figure "gpcs[5:4] = 2b'10" and gpcs [3:0] = 4b'1101 (n=13) to have $V_{internal\ R} = (1/5)^*V_{DD} + [(13+1)/40]^*V_{DD} = [(13+9)/40]^*V_{DD} = (22/40)^*V_{DD}$.

```
gpcs = 0b1_0_10_1101;  // output to PA0, V_{internal\ R} = V_{DD}*(22/40)

gpcc = 0b1_0_0_1_011_1;  // Inverse output, - input: V_{internal\ R}, + input: PA4

padier = 0bxxx_0_xxxx;  // disable PA4 digital input to prevent leakage current

or

$ GPCS Output, V_{DD}*22/40;

$ GPCC Enable, Inverse, N_R, P_PA4; // - input: N_R(V_{internal\ R}), + input: P_xx

PADIER = 0bxxx_0_xxxx;
```

Note: When selecting output to PA0 output, GPCS will affect the PA3 output function in ICE. Though the IC is fine, be careful to avoid this error during emulation.



5.12.3 Using the comparator and band-gap 1.20V

The internal band-gap module provides a stable 1.20V output, and it can be used to measure the external supply voltage level. The band-gap 1.20V is selected as minus input of comparator and $V_{internal\ R}$ is selected as plus input, the supply voltage of $V_{internal\ R}$ is V_{DD} , the V_{DD} voltage level can be detected by adjusting the voltage level of $V_{internal\ R}$ to compare with band-gap. If N (gpcs[3:0] in decimal) is the number to let $V_{internal\ R}$ closest to band-gap 1.20 volt, the supply voltage V_{DD} can be calculated by using the following equations:

```
 \begin{array}{ll} \mbox{For using Case 1:} & V_{DD} = [\ 32\ /\ (N+9)\ ]\ ^*\ 1.20\ volt\ ; \\ \mbox{For using Case 2:} & V_{DD} = [\ 24\ /\ (N+1)\ ]\ ^*\ 1.20\ volt\ ; \\ \mbox{For using Case 3:} & V_{DD} = [\ 40\ /\ (N+9)\ ]\ ^*\ 1.20\ volt\ ; \\ \mbox{For using Case 4:} & V_{DD} = [\ 32\ /\ (N+1)\ ]\ ^*\ 1.20\ volt\ ; \\ \end{array}
```

Case 1:



5.13. 8-bit Timer with PWM generation (Timer2, Timer3)

Two 8-bit hardware timers (Timer2/TM2, Timer3/TM3) with PWM generation are implemented in the PFS154, Timer2 is used as the example to describe its function due to these two 8-bit timers are the same. Please refer to Fig. 14 shown its hardware diagram, the clock sources of Timer2 may come from system clock, internal high RC oscillator (IHRC) or, internal low RC oscillator (ILRC), external crystal oscillator (EOSC), PA0, PA4, PB0 or comparator. Bit[7:4] of register tm2c are used to select the clock source of Timer2. Please notice that if IHRC is selected for Timer2 clock source, the clock sent to Timer2 will keep running when using ICE in halt state. The output of Timer2 can be sent to pin PA3, PB2 or PB4, depending on bit [3-2] of tm2c register (PB5, PB6 and PB7 for Timer3). A clock pre-scaling module is provided with divided-by-1, 4, 16, and 64 options, controlled by bit [6:5] of tm2s register; one scaling module with divided-by-1~31 is also provided and controlled by bit [4:0] of tm2s register. In conjunction of pre-scaling function and scaling function, the frequency of Timer2 clock (TM2_CLK) can be wide range and flexible.

The Timer2 counter performs 8-bit up-counting operation only; the counter values can be set or read back by tm2ct register. The 8-bit counter will be clear to zero automatically when its values reach for upper bound register, the upper bound register is used to define the period of timer or duty of PWM. There are two operating modes for Timer2: period mode and PWM mode; period mode is used to generate periodical output waveform or interrupt event; PWM mode is used to generate PWM output waveform with optional 6-bit to 8-bit PWM resolution, Fig. 15 shows the timing diagram of Timer2 for both period mode and PWM mode.

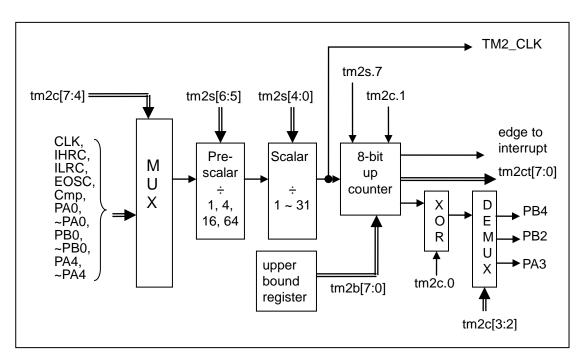


Fig. 14: Timer2 hardware diagram



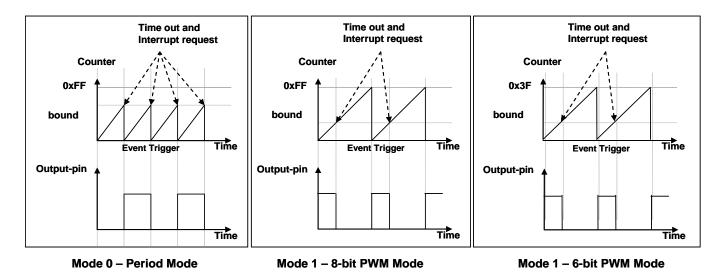


Fig. 15: Timing diagram of Timer2 in period mode and PWM mode (tm2c.1=1)

5.13.1 Using the Timer2 to generate periodical waveform

If periodical mode is selected, the duty cycle of output is always 50%; its frequency can be summarized as below:

Frequency of Output = $Y \div [2 \times (K+1) \times S1 \times (S2+1)]$

Where, Y = tm2c[7:4]: frequency of selected clock source

K = tm2b[7:0]: bound register in decimal S1 = tm2s[6:5]: pre-scalar (1, 4, 16, 64)

S2 = tm2s[4:0]: scalar register in decimal (1 ~ 31)

Example 1:

 $tm2c = 0b0001_1000, Y=8MHz$

tm2b = 0b0111 1111, K=127

 $tm2s = 0b0_00_000000, S1=1, S2=0$

 \rightarrow frequency of output = 8MHz \div [2 x (127+1) x 1 x (0+1)] = 31.25KHz

Example 2:

 $tm2c = 0b0001_1000, Y=8MHz$

 $tm2b = 0b0111_1111, K=127$

 $tm2s[7:0] = 0b0_11_11111, S1=64, S2 = 31$

→ frequency = $8MHz \div (2 \times (127+1) \times 64 \times (31+1)) = 15.25Hz$

Example 3:

 $tm2c = 0b0001_1000, Y=8MHz$

 $tm2b = 0b0000_{-}1111, K=15$

tm2s = 0b0 00 00000, S1=1, S2=0

→ frequency = $8MHz \div (2 \times (15+1) \times 1 \times (0+1)) = 250KHz$

Example 4:

```
tm2c = 0b0001_1000, Y=8MHz

tm2b = 0b0000_0001, K=1

tm2s = 0b0_00_00000, S1=1, S2=0

\rightarrow frequency = 8MHz \div ( 2 × (1+1) × 1 × (0+1) ) =2MHz
```

The sample program for using the Timer2 to generate periodical waveform to PA3 is shown as below:

5.13.2 Using the Timer2 to generate 8-bit PWM waveform

If 8-bit PWM mode is selected, it should set *tm2c*[1]=1 and *tm2s*[7]=0, the frequency and duty cycle of output waveform can be summarized as below:

```
Frequency of Output = Y \div [256 \times S1 \times (S2+1)]
Duty of Output = [(K+1) \div 256] \times 100\%
```

```
Where, Y = tm2c[7:4]: frequency of selected clock source K = tm2b[7:0]: bound register in decimal S1 = tm2s[6:5]: pre-scalar (1, 4, 16, 64) S2 = tm2s[4:0]: scalar register in decimal (1 ~ 31)
```

Example 1:

```
tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b0111_1111, K=127

tm2s = 0b0_00_00000, S1=1, S2=0

\rightarrow frequency of output = 8MHz \div ( 256 \times 1 \times (0+1) ) = 31.25KHz

\rightarrow duty of output = [(127+1) \div 256] \times 100% = 50%
```

Example 2:

```
tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b0111_1111, K=127

tm2s = 0b0_11_11111, S1=64, S2=31

\rightarrow frequency of output = 8MHz \div ( 256 \times 64 \times (31+1) ) = 15.25Hz

\rightarrow duty of output = [(127+1) \div 256] \times 100% = 50%
```



Example 3:

```
tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b1111_1111, K=255

tm2s = 0b0_00_00000, S1=1, S2=0

\rightarrow frequency of output = 8MHz \div ( 256 \times 1 \times (0+1) ) = 31.25KHz

\rightarrow duty of output = [(255+1) \div 256] \times 100% = 100%
```

Example 4:

```
tm2c = 0b0001_1010, Y=8MHz

tm2b = 0b0000_1001, K = 9

tm2s = 0b0_00_00000, S1=1, S2=0

\rightarrow frequency of output = 8MHz \div ( 256 \times 1 \times (0+1) ) = 31.25KHz

\rightarrow duty of output = [(9+1) \div 256] \times 100% = 3.9%
```

The sample program for using the Timer2 to generate PWM waveform from PA3 is shown as below:

```
void
        FPPA0 (void)
{
                 SYSCLK=IHRC/2, IHRC=16MHz, V_{DD}=5V
   .ADJUST_IC
   wdreset;
   tm2ct = 0x0;
   tm2b = 0x7f;
                               //
   tm2s = 0b0\_00\_00001;
                                     8-bit PWM, pre-scalar = 1, scalar = 2
   tm2c = 0b0001\_10\_1\_0;
                                //
                                     system clock, output=PA3, PWM mode
   while(1)
   {
        nop;
}
```

5.13.3 Using the Timer2 to generate 6-bit PWM waveform

If 6-bit PWM mode is selected, it should set *tm2c*[1]=1 and *tm2s*[7]=1, the frequency and duty cycle of output waveform can be summarized as below:

Frequency of Output = $Y \div [64 \times S1 \times (S2+1)]$

Duty of Output = $[(K+1) \div 64] \times 100\%$

Where, tm2c[7:4] = Y: frequency of selected clock source

tm2b[7:0] = K : bound register in decimal<math>tm2s[6:5] = S1 : pre-scalar (1, 4, 16, 64)

tm2s[4:0] = S2 : scalar register in decimal (1 ~ 31)

Example 1:

 $tm2c = 0b0001_1010, Y=8MHz$

tm2b = 0b0001 1111, K=31

 $tm2s = 0b1_00_00000$, S1=1, S2=0

 \rightarrow frequency of output = 8MHz \div (64 x 1 x (0+1)) = 125KHz

 \rightarrow duty = [(31+1) \div 64] \times 100% = 50%

Example 2:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b0001_11111, K=31$

tm2s = 0b1_11_11111, S1=64, S2=31

 \rightarrow frequency of output = 8MHz \div (64 x 64 x (31+1)) = 61.03Hz

 \rightarrow duty of output = [(31+1) \div 64] × 100% = 50%

Example 3:

 $tm2c = 0b0001_1010, Y=8MHz$

 $tm2b = 0b0011_1111, K=63$

 $tm2s = 0b1_00_00000$, S1=1, S2=0

→ frequency of output = $8MHz \div (64 \times 1 \times (0+1)) = 125KHz$

 \rightarrow duty of output = [(63+1) \div 64] \times 100% = 100%

Example 4:

tm2c = 0b0001 1010, Y=8MHz

 $tm2b = 0b0000_0000, K=0$

tm2s = 0b1_00_00000, S1=1, S2=0

 \rightarrow Frequency = 8MHz \div (64 x 1 x (0+1)) = 125KHz

 \rightarrow Duty = [(0+1) \div 64] \times 100% =1.5%



5.14. 11-bit PWM generation

Three 11-bit hardware PWM generators (PWMG0, PWMG1 & PWMG2) are implemented in the PFS154. PWMG0 is used as the example to describe its functions due to all of them are almost the same. Their individual outputs are listed as below:

- PWMG0 PA0, PB4, PB5
- PWMG1 PA4, PB6, PB7
- PWMG2 PA3, PB2, PB3, PA5 (open drain output only, and ICE does not support)

5.14.1 PWM Waveform

A PWM output waveform (Fig. 16) has a time-base (T_{Period} = Time of Period) and a time with output high level (Duty Cycle). The frequency of the PWM output is the inverse of the period ($f_{PWM} = 1/T_{Period}$), the resolution of the PWM is the clock count numbers for one period (N bits resolution, $2^N \times T_{clock} = T_{Period}$).

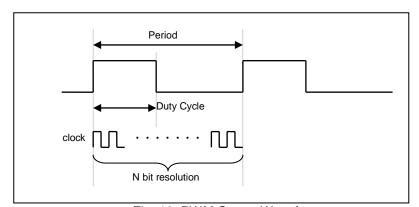


Fig. 16: PWM Output Waveform



5.14.2 Hardware and Timing Diagram

Fig. 17 shows the hardware diagram of 11-bit Timer. The clock source can be IHRC or system clock and output pin can be PA0, PB4 or PB5 via *pwmc* register selection. The period of PWM waveform is defined in the PWM upper bond high and low registers, the duty cycle of PWM waveform is defined in the PWM duty high and low registers.

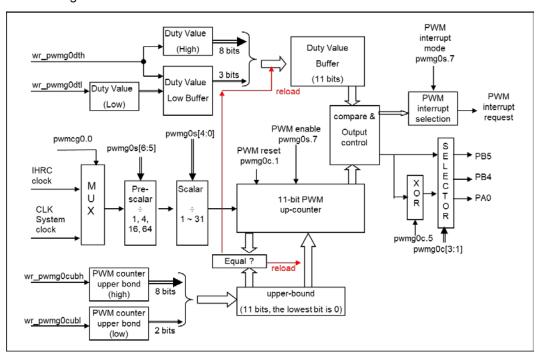


Fig. 17: Hardware Diagram of 11-bit PWM Generator 0 (PWMG0)

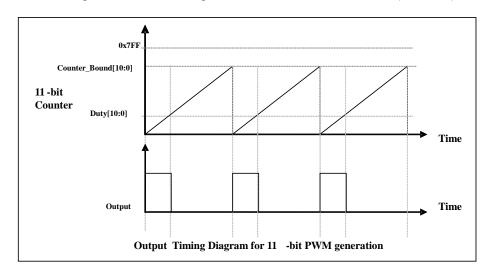


Fig. 18: Output Timing Diagram of 11-bit PWM Generator



5.14.3 Equations for 11-bit PWM Generator

If F_{IHRC} is the frequency of IHRC oscillator and IHRC is the chosen clock source for 11-bit PWM generator, the PWM frequency and duty cycle in time will be:

Frequency of PWM Output = $F_{IHRC} \div [P \times (K + 1) \times CB]$ Duty Cycle of PWM Output (in time) = $(1/F_{IHRC}) * [DB10_1 + DB0 * 0.5 + 0.5]$

Where, $pwms[6:5] = \mathbf{P}$; pre-scalar

 $pwms[4:0] = \mathbf{K}$; scalar

 $Duty_Bound[10:1] = \{ pwmgxdth [7:0], pwmgxdtl[7:6] \} = \textbf{DB10_1}; duty bound$

 $Duty_Bound[0] = pwmgxdtl[5] = DB0$

Counter_Bound[10:1] = { pwmgxcubh [7:0], pwmgxcubl [7:6]} = **CB**; counter bount



6. IO Registers

6.1. ACC Status Flag Register (flag), IO address = 0x00

Bit	Reset	R/W	Description	
7 - 4		ı	Reserved. These four bits are "1" when read.	
3	-	R/W	OV (Overflow). This bit is set whenever the sign operation is overflow.	
2	1	R/W	AC (Auxiliary Carry). There are two conditions to set this bit, the first one is carry out of low nibble in addition operation, and the other one is borrow from the high nibble into low nibble in subtraction operation.	
1	-	R/W	C (Carry). There are two conditions to set this bit, the first one is carry out in addition operation, and the other one is borrow in subtraction operation. Carry is also affected by shift with carry instruction.	
0	-	R/W	Z (Zero). This bit will be set when the result of arithmetic or logic operation is zero; Otherwise, it is cleared.	

6.2. Stack Pointer Register (sp), IO address = 0x02

Bit	Reset	R/W	Description
			Stack Pointer Register. Read out the current stack pointer, or write t
7 - 0	-	R/W	o change the stack pointer. Please notice that bit 0 should be kept 0 due to program counter
			is 16 bits.

6.3. Clock Mode Register (*clkmd*), IO address = 0x03

Bit	Reset	R/W	Descr	ription	
			System clock selection:		
			Type 0, clkmd[3]=0	Type 1, clkmd[3]=1	
			000: IHRC/4	000: IHRC/16	
			001: IHRC/2	001: IHRC/8	
7 - 5	111	R/W	010: reserved	010: ILRC/16 (ICE does NOT Support.)	
7 - 3	111	IX/VV	011: EOSC/4	011: IHRC/32	
			100: EOSC/2	100: IHRC/64	
			101: EOSC	101: EOSC/8	
			110: ILRC/4	Others: reserved	
			111: ILRC (default)		
4	1	R/W	IHRC oscillator Enable. 0 / 1: disable / enable		
3	0	DW	Clock Type Select. This bit is used to select th	e clock type in bit [7:5].	
3	0	RW	0 / 1: Type 0 / Type 1		
	4	R/W	ILRC Enable. 0 / 1: disable / enable		
2	1		If ILRC is disabled, watchdog timer is also disa	abled.	
1	1	R/W	Watch Dog Enable. 0 / 1: disable / enable		
0	0	R/W	Pin PA5/PRST# function. 0 / 1: PA5 / PRST#		



6.4. Interrupt Enable Register (inten), IO address = 0x04

Bit	Reset	R/W	Description
7	-	R/W	Enable interrupt from Timer3. 0 / 1: disable / enable.
6	1	R/W	Enable interrupt from Timer2. 0 / 1: disable / enable.
5	-	R/W	Enable interrupt from PWMG0. 0 / 1: disable / enable.
4	-	R/W	Enable interrupt from comparator. 0 / 1: disable / enable.
3		R/W	Reserved.
2	-	R/W	Enable interrupt from Timer16 overflow. 0 / 1: disable / enable.
1	-	R/W	Enable interrupt from PB0. 0 / 1: disable / enable.
0	-	R/W	Enable interrupt from PA0. 0 / 1: disable / enable.

6.5. Interrupt Request Register (intrq), IO address = 0x05

Bit	Reset	R/W	Description	
_	7	R/W	Interrupt Request from Timer3, this bit is set by hardware and cleared by software.	
7	-	K/VV	0 / 1: No request / Request	
		DAM	Interrupt Request from Timer2, this bit is set by hardware and cleared by software.	
6	-	R/W	0 / 1: No request / Request	
_		D // /	Interrupt Request from PWMG0, this bit is set by hardware and cleared by software.	
5	-	R/W	0 / 1: No request / Request	
4		D 444	Interrupt Request from comparator, this bit is set by hardware and cleared by software.	
4	-	R/W	0 / 1: No request / Request	
3	-	1	Reserved.	
		D 447	Interrupt Request from Timer16, this bit is set by hardware and cleared by software.	
2	-	•	R/W	0 / 1: No request / Request
	-	D 44/	Interrupt Request from pin PB0, this bit is set by hardware and cleared by software.	
1		R/W	0 / 1: No request / Request	
		D 44/	Interrupt Request from pin PA0, this bit is set by hardware and cleared by software.	
0	0 -	R/W	0 / 1: No request / Request	



6.6. Timer 16 mode Register (t16m), IO address = 0x06

Bit	Reset	R/W	Description
			Timer Clock source selection
			000: Timer 16 is disabled
			001: CLK (system clock)
			010: reserved
7 - 5	000	R/W	011: PA4 falling edge (from external pin)
			100: IHRC
			101: EOSC
			110: ILRC
			111: PA0 falling edge (from external pin)
			Internal clock divider.
			00: /1
4 - 3	00	R/W	01: /4
			10: /16
			11: /64
			Interrupt source selection. Interrupt event happens when selected bit is changed.
			0 : bit 8 of Timer16
			1 : bit 9 of Timer16
			2 : bit 10 of Timer16
2 - 0	000	R/W	3 : bit 11 of Timer16
			4 : bit 12 of Timer16
			5 : bit 13 of Timer16
			6 : bit 14 of Timer16
			7 : bit 15 of Timer16

6.7. External Oscillator setting Register (eoscr, write only), IO address = 0x0a

Bit	Reset	R/W	Description
7	0	WO	Enable external crystal oscillator. 0 / 1 : Disable / Enable
			External crystal oscillator selection.
			00 : reserved
6 - 5	00	WO	01 : Low driving capability, for lower frequency, ex: 32KHz crystal oscillator
			10 : Middle driving capability, for middle frequency, ex: 1MHz crystal oscillator
			11 : High driving capability, for higher frequency, ex: 4MHz crystal oscillator
4 - 1	-	1	Reserved. Please keep 0 for future compatibility.
0	0	WO	Power-down the Band-gap and LVR hardware modules. 0 / 1: normal / power-down.



6.8. Interrupt Edge Select Register (integs), IO address = 0x0c

Bit	Reset	R/W	Description
7 - 5	-	•	Reserved.
			Timer16 edge selection.
4	0	WO	0 : rising edge to trigger interrupt
			1 : falling edge to trigger interrupt
			PB0 edge selection.
			00 : both rising edge and falling edge to trigger interrupt
3 - 2	00	WO	01 : rising edge to trigger interrupt
			10 : falling edge to trigger interrupt
			11 : reserved.
			PA0 edge selection.
			00 : both rising edge and falling edge to trigger interrupt
1 - 0	00	WO	01 : rising edge to trigger interrupt
			10 : falling edge to trigger interrupt
			11 : reserved.

6.9. Port A Digital Input Enable Register (padier), IO address = 0x0d

Bit	Reset	R/W	Description
7 - 3	11111	WO	Enable PA7~PA3 wake up event. 1 / 0 : enable / disable.
7 - 3			When this bit is "0", the function is disable to wake up from PA7~PA3 toggling.
2 - 1	-	-	Reserved.
0	1	WO	Enable PA0 wake up event and interrupt request. 1 / 0 : enable / disable. When this bit is "0", the function is disable wake up from PA0 toggling and interrupt request from this pin.

6.10. Port B Digital Input Enable Register (pbdier), IO address = 0x0e

Bit	Reset	R/W	Description
7 - 0	8'hFF	1 H H I VV() I	Enable PB7~PB0 wake up event. 1 / 0 : enable / disable.
7 - 0			When this bit is "0", the function is disable wake up from PB7~PB0 toggling.

6.11. Port A Data Registers (pa), IO address = 0x10

Bit	Reset	R/W	Description
7 - 0	8'h00	R/W	Data registers for Port A.

6.12. Port A Control Registers (pac), IO address = 0x11

Bit	Reset	R/W	Description
7 - 0	8'h00	I R////	Port A control registers. This register is used to define input mode or output mode for each corresponding pin of port A. 0 / 1: input / output.

6.13. Port A Pull-High Registers (paph), IO address = 0x12

Bit	Reset		Description
7 - 0	8'h00	R/W	Port A pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port A. 0 / 1 : disable / enable



6.14. Port B Data Registers (pb), IO address = 0x14

Bit	Reset	R/W	Description
7 - 0	8'h00	R/W	Data registers for Port B.

6.15. Port B Control Registers (pbc), IO address = 0x15

	Bit	Reset	R/W	Description
7	· - 0	8'h00	I R////	Port B control registers. This register is used to define input mode or output mode for each corresponding pin of port B. 0 / 1: input / output.

6.16. Port B Pull-High Registers (pbph), IO address = 0x16

Bi	t	Reset	R/W	Description
7 –	0	8'h00	R/W	Port B pull-high registers. This register is used to enable the internal pull-high device on each corresponding pin of port B. 0 / 1 : disable / enable

6.17. MISC Register (misc), IO address = 0x08

Bit	Reset	R/W	Description
7 - 6	-	-	Reserved. (keep 0 for future compatibility)
			Enable fast Wake up. Fast wake-up is NOT supported when EOSC is enabled.
			0: Normal wake up.
5	0	WO	The wake-up time is 3000 ILRC clocks (Not for fast boot-up)
			1: Fast wake up.
			The wake-up time is 45 ILRC clocks.
			Enable VDD/2 bias voltage generator
			0 / 1 : Disable / Enable (ICE cannot be dynamically switched)
4	0	WO	If Code Option selects LCD output, but MISC.4 does not set to 1, then the VDD/2 bias
			cannot be output on the IC. However, the emulator is always OK. Two above phenomena
			are different.
3	-	-	Reserved.
2	0	WO	Disable LVR function.
	0	WO	0 / 1 : Enable / Disable
			Watch dog time out period
			00: 8192 ILRC clock period
1 - 0	00	WO	01: 16384 ILRC clock period
			10: 65536 ILRC clock period
			11: 262144 ILRC clock period



6.18. Timer2 Control Register (tm2c), IO address = 0x1c

Bit	Reset	R/W	Description
7 - 4	0000	R/W	Timer2 clock selection. 0000 : disable 0001 : CLK 0010 : IHRC 0011 : EOSC 0100 : ILRC 0101 : comparator output 1000 : PA0 (rising edge) 1001 : ~PA0 (falling edge) 1010 : PB0 (rising edge) 1011 : ~PB0 (falling edge) 1100 : PA4 (rising edge) 1101 : ~PA4 (falling edge) 1101 : ~PA4 (falling edge) 1101 : ~PA4 (falling edge)
3 - 2	00	R/W	Timer2 output selection. 00 : disable 01 : PB2 10 : PA3 11 : PB4
1	0	R/W	Timer2 mode selection. 0 / 1 : period mode / PWM mode
0	0	R/W	Enable to inverse the polarity of Timer2 output. 0 / 1: disable / enable

6.19. Timer2 Counter Register (tm2ct), IO address = 0x1d

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Bit [7:0] of Timer2 counter register.

6.20. Timer2 Scalar Register (tm2s), IO address = 0x17

Bit	Reset	R/W	Description
7	0	WO	PWM resolution selection. 0:8-bit 1:6-bit
6 - 5	00	WO	Timer2 clock pre-scalar. 00 : ÷ 1 01 : ÷ 4 10 : ÷ 16 11 : ÷ 64
4 - 0	00000	WO	Timer2 clock scalar.



6.21. Timer2 Bound Register (tm2b), IO address = 0x09

Bit	Reset	R/W	Description
7 - 0	0x00	WO	Timer2 bound register.

6.22. Timer3 Control Register (tm3c), IO address = 0x32

Bit	Reset	R/W	Description
7 - 4	0000	R/W	Timer3 clock selection. 0000: disable 0001: CLK 0010: IHRC 0011: EOSC 0100: ILRC 0101: comparator output 1000: PA0 (rising edge) 1001: ~PA0 (falling edge) 1010: PB0 (rising edge) 1011: ~PB0 (falling edge) 1100: PA4 (rising edge) 1101: ~PA4 (falling edge) 1101: ~PA5 (falling edge) 1101: ~PA6 (falling edge) 1101: ~PA7 (falling edge) 1101: ~PA8 (falling edge) 1101: ~PA8 (falling edge) 1101: ~PA9 (falling edge) 1101: ~PA9 (falling edge)
3 - 2	00	R/W	Timer3 output selection. 00 : disable 01 : PB5 10 : PB6 11 : PB7
1	0	R/W	Timer3 mode selection. 0 / 1 : period mode / PWM mode
0	0	R/W	Enable to inverse the polarity of Timer3 output. 0 / 1: disable / enable

6.23. Timer3 Counter Register (tm3ct), IO address = 0x33

Bit	Reset	R/W	Description
7 - 0	0x00	R/W	Bit [7:0] of Timer2 counter register.



6.24. Timer3 Scalar Register (tm3s), IO address = 0x34

Bit	Reset	R/W	Description
			PWM resolution selection.
7	0	WO	0:8-bit
			1:6-bit
			Timer3 clock pre-scalar.
			00 : ÷ 1
6 - 5	00	WO	01 : ÷ 4
			10 : ÷ 16
			11 : ÷ 64
4 - 0	00000	WO	Timer3 clock scalar.

6.25. Timer3 Bound Register (tm3b), IO address = 0x35

Bit	Reset	R/W	Description
7 - 0	0x00	WO	Timer3 bound register.

6.26. Comparator Control Register (*gpcc*), IO address = 0x18

Bit	Reset	R/W	Description
7	0	R/W	Enable comparator. 0 / 1 : disable / enable When this bit is set to enable, please also set the corresponding analog input pins to be digital disable to prevent IO leakage.
6	-	RO	Comparator result 0: plus input < minus input 1: plus input > minus input
5	0	R/W	Select whether the comparator result output will be sampled by TM2_CLK? 0: result output NOT sampled by TM2_CLK 1: result output sampled by TM2_CLK
4	0	R/W	Inverse the polarity of result output of comparator. 0: polarity is NOT inversed. 1: polarity is inversed.
3 - 1	000	R/W	Selection the minus input (-) of comparator. 000: PA3 001: PA4 010: Internal 1.20 volt band-gap reference voltage 011: V _{internal R} 100: PB6 (not for EV5) 101: PB7 (not for EV5) 11X: reserved
0	0	R/W	Selection the plus input (+) of comparator. 0: V _{internal R} 1: PA4



6.27. Comparator Selection Register (gpcs), IO address = 0x19

Bit	Reset	R/W	Description
		WO	Comparator output enable (to PA0).
7	0		0 / 1 : disable / enable
/	0		(Please avoid this situation: GPCS will affect the PA3 output function when selecting
			output to PA0 output in ICE.)
6	-	-	Reserved.
5	0	WO	Selection of high range of comparator.
4	0	WO	Selection of low range of comparator.
3 - 0	0000 WO Selection the voltage level of compa	Selection the voltage level of comparator.	
3-0	0000	VVO	0000 (lowest) ~ 1111 (highest)

6.28. PWMG0 control Register (pwmg0c), IO address = 0x20

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG0 generator. 0 / 1 : disable / enable.
6	-	RO	Output status of PWMG0 generator.
5	0	R/W	Enable to inverse the polarity of PWMG0 generator output. 0 / 1 : disable / enable.
4	0	R/W	PWMG0 counter reset. Writing "1" to clear PWMG0 counter.
3-1	0	R/W	Select PWM output pin for PWMG0. 000: none 001: PB5 011: PA0 100: PB4 Others: reserved
0	0	R/W	Clock source of PWMG0 generator. 0: SYSCLK, 1: IHRC

6.29. PWMG0 Scalar Register (pwmg0s), IO address = 0x21

Bit	Reset	R/W	Description
7	0	WO	PWMG0 interrupt mode. 0: Generate interrupt when counter matches the duty value 1: Generate interrupt when counter is 0.
6 - 5	0	WO	PWMG0 clock pre-scalar. 00 : ÷1 01 : ÷4 10 : ÷16 11 : ÷64
4 - 0	0	WO	PWMG0 clock divider.

6.30. PWMG0 Counter Upper Bound High Register (pwmg0cubh), IO address = 0x24

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG0 counter upper bound.



6.31. PWMG0 Counter Upper Bound Low Register (pwmg0cubl), IO address = 0x25

Bit	Reset	R/W	Description
7 - 6	000	WO	Bit[2:1] of PWMG0 counter upper bound.
5 - 0	-	-	Reserved

6.32. PWMG0 Duty Value High Register (pwmg0dth), IO address = 0x22

Bit	Reset	R/W	Description
7 - 0	0x00	WO	Duty values bit[10:3] of PWMG0.

6.33. PWMG0 Duty Value Low Register (pwmg0dtl), IO address = 0x23

Bit	Reset	R/W	Description
7 - 5	000	WO	Duty values bit [2:0] of PWMG0.
4 - 0	-	-	Reserved

Note: It's necessary to write PWMG0 Duty_Value Low Register before writing PWMG0 Duty_Value High Register.

6.34. PWMG1 control Register (pwmg1c), IO address = 0x26

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG1. 0 / 1 : disable / enable.
6	-	RO	Output of PWMG1.
5	0	R/W	Enable to inverse the polarity of PWMG1 output. 0 / 1 : disable / enable.
4	0	R/W	PWMG1 counter reset. Writing "1" to clear PWMG1 counter and this bit will be self clear to 0 after counter reset.
3 - 1	0	R/W	Select PWMG1 output pin. 000: none 001: PB6 011: PA4 100: PB7 Others: reserved
0	0	R/W	Clock source of PWMG1. 0: SYSCLK, 1: IHRC



6.35. PWMG1 Scalar Register (pwmg1s), IO address = 0x27

Bit	Reset	R/W	Description
7	0	WO	PWMG1 interrupt mode. 0: Generate interrupt when counter matches the duty value 1: Generate interrupt when counter is 0.
6 - 5	0	WO	PWMG1 clock pre-scalar. 00 : ÷1 01 : ÷4 10 : ÷16 11 : ÷64
4 - 0	0	WO	PWMG1 clock divider.

6.36. PWMG1 Counter Upper Bound High Register (pwmg1cubh), IO address = 0x2a

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG1 counter upper bound.

6.37. PWMG1 Counter Upper Bound Low Register (pwmg1cubl), IO address = 0x2b

Bit	Reset	R/W	Description
7 - 6	-	WO	Bit[2:1] of PWMG1 counter upper bound.
5 - 0	-	-	Reserved

6.38. PWMG1 Duty Value High Register (pwmg1dth), IO address = 0x28

Bit	Reset	R/W	Description
7 - 0	-	WO	Duty values bit[10:3] of PWMG1.

6.39. PWMG1 Duty Value Low Register (pwmg1dtl), IO address = 0x29

Bit	Reset	R/W	Description
7 - 5	-	WO	Duty values bit[2:0] of PWMG1.
4 - 0	-	-	Reserved

Note: It's necessary to write PWMG1 Duty_Value Low Register before writing PWMG1 Duty_Value High Register.



6.40. PWMG2 control Register (pwmg2c), IO address = 0x2c

Bit	Reset	R/W	Description
7	0	R/W	Enable PWMG2. 0 / 1: disable / enable.
6	-	RO	Output of PWMG2.
5	0	R/W	Enable to inverse the polarity of PWMG2 output. 0 / 1: disable / enable.
4	0	R/W	PWMG2 counter reset. Writing "1" to clear PWMG2 counter and this bit will be self clear to 0 after counter reset.
3 - 1	0	R/W	Select PWMG2 output pin. 000: disable 001: PB3 011: PA3 100: PB2 101: PA5 (ICE does NOT Support.) Others: reserved
0	0	R/W	Clock source of PWMG2. 0: SYSCLK, 1: IHRC

6.41. PWMG2 Scalar Register (pwmg2s), IO address = 0x2d

Bit	Reset	R/W	Description
			PWMG2 interrupt mode.
7	0	WO	0: Generate interrupt when counter matches the duty value
			1: Generate interrupt when counter is 0.
			PWMG2 clock pre-scalar.
			00 : ÷1
6 - 5	0	WO	01 : ÷4
			10 : ÷16
			11 : ÷64
4 - 0	0	WO	PWMG2 clock divider.

6.42. PWMG2 Counter Upper Bound High Register (pwmg2cubh), IO address = 0x30

Bit	Reset	R/W	Description
7 - 0	-	WO	Bit[10:3] of PWMG2 counter upper bound.

6.43. PWMG2 Counter Upper Bound Low Register (pwmg2cubl), IO address = 0x31

Bit	Reset	R/W	Description
7 - 6	-	WO	Bit[2:1] of PWMG2 counter upper bound.
5 - 0	-	1	Reserved

6.44. PWMG2 Duty Value High Register (pwmg2dth), IO address = 0x2e

Bit	Reset	R/W	Description
7 – 0	-	WO	Duty values bit[10:3] of PWMG2.



6.45. PWMG2 Duty Value Low Register (pwmg2dtl), IO address = 0x2f

Bit	Reset	R/W	Description
7 – 5	-	WO	Duty values bit[2:0] of PWMG2.
4 – 0	-	-	Reserved

Note: It's necessary to write PWMG2 Duty_Value Low Register before writing PWMG2 Duty_Value High Register.



7. Instructions

Symbol	Description	
ACC	Accumulator (Abbreviation of accumulator)	
а	Accumulator (Symbol of accumulator in program)	
sp	Stack pointer	
flag	ACC status flag register	
I	Immediate data	
&	Logical AND	
I	Logical OR	
←	Movement	
^	Exclusive logic OR	
+	Add	
_	Subtraction	
~	NOT (logical complement, 1's complement)	
₹	NEG (2's complement)	
ov	Overflow (The operational result is out of range in signed 2's complement number system)	
Z	Zero (If the result of ALU operation is zero, this bit is set to 1)	
С	Carry (The operational result is to have carry out for addition or to borrow carry for subtraction in	
40	unsigned number system)	
AC	Auxiliary Carry (If there is a carry out from low nibble after the result of ALU operation, this bit is set to 1)	
IO.n	BIT of IO	
M.n,	Bit of Memory	



7.1. Data Transfer Instructions

mov	a, I	Move immediate data into ACC.
		Example: mov a, 0x0f;
		Result: a ← 0fh;
		Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
mov	M, a	Move data from ACC into memory
		Example: mov MEM, a;
		Result: MEM ← a
		Affected flags: "N』Z "N』C "N』AC "N』OV
mov	a, M	Move data from memory into ACC
		Example: mov a, MEM;
		Result: a ← MEM; Flag Z is set when MEM is zero.
		Affected flags: "Y』Z "N』C "N』AC "N』OV
mov	a, IO	Move data from IO into ACC
	,	Example: mov a, pa;
		Result: a ← pa; Flag Z is set when pa is zero.
		Affected flags: "Y J Z "N J C "N J AC "N J OV
mov	IO, a	Move data from ACC into IO
	. . , a	Example: mov pa, a;
		Result: pa ← a
		Affected flags: "N』Z "N』C "N』AC "N』OV
Idt16	word	Move 16-bit counting values in Timer16 to memory in word.
idiro	Word	Example: ldt16 word;
		Result: word ← 16-bit timer
		Affected flags: "N Z "N C "N AC "N OV
		Allected liags. The Z The C The AC The OV
		Application Example:
		Application Example:
		word T16val; // declare a RAM word
		olegr
		clear lb@ T16val; // clear T16val (LSB)
		clear hb@ T16val; // clear T16val (MSB)
		stt16 T16val; // initial T16 with 0
		set1 t16m.5; // enable Timer16
		set0 t16m.5; // disable Timer 16
		ldt16 T16val; // save the T16 counting value to T16val
		••••



-44C	Chara 4C hit data from managerin ward to Time #4C					
stt16 word	Store 16-bit data from memory in word to Timer16.					
	Example: stt16 word;					
	Result: 16-bit timer ←word					
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV Application Example:					
	word T16val; // declare a RAM word					
	mov a, 0x34;					
	mov lb@ T16val, a; // move 0x34 to T16val (LSB)					
	mov a, 0x12;					
	mov hb@ T16val , a ; // move 0x12 to T16val (MSB)					
	stt16 T16val; // initial T16 with 0x1234					
idxm a, inde	 Move data from specified memory to ACC by indirect method. It needs 2T to execute this instruction. Example: idxm a, index; Result: a ← [index], where index is declared by word. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV 					
	Application Example:					
	word RAMIndex; // declare a RAM pointer					
	mov a OvEP: // accign pointer to an address (LSP)					
	mov a, 0x5B; // assign pointer to an address (LSB) mov lb@RAMIndex, a; // save pointer to RAM (LSB)					
	mov a, 0x00; // assign 0x00 to an address (MSB), should be 0					
	mov hb@RAMIndex, a; // save pointer to RAM (MSB)					
	idxm a, RAMIndex; // move memory data in address 0x5B to ACC					



Idxm index, a	Move data from ACC to specified memory by indirect method. It needs 2T to execute this instruction. Example: idxm index, a; Result: [index] ← a; where index is declared by word. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV Application Example:					
	word RAMIndex; // declare a RAM pointer mov a, 0x5B; // assign pointer to an address (LSB)					
	movlb@RAMIndex, a;// save pointer to RAM (LSB)mova, 0x00;// assign 0x00 to an address (MSB), should be 0movhb@RAMIndex, a;// save pointer to RAM (MSB)					
	mov a, 0xA5; idxm RAMIndex, a; // move 0xA5 to memory in address 0x5B					
xch M	Exchange data between ACC and memory Example: xch MEM; Result: MEM ← a , a ← MEM Affected flags: 『N』Z 『N』C 『N』AC 『N』OV					
pushaf	Move the ACC and flag register to memory that address specified in the stack pointer. Example: pushaf; Result: [sp] ← {flag, ACC}; sp ← sp + 2; Affected flags: 『N』Z 『N』C 『N』AC 『N』OV					
	Application Example:					
	.romadr 0x10; // ISR entry address pushaf; // put ACC and flag into stack memory // ISR program // ISR program popaf; // restore ACC and flag from stack memory reti;					
popaf	Restore ACC and flag from the memory which address is specified in the stack pointer. Example: popaf; Result: sp ← sp - 2; {Flag, ACC} ← [sp]; Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV					



7.2. Arithmetic Operation Instructions

	•
add a, I	Add immediate data with ACC, then put result into ACC
	Example: add a, 0x0f;
	Result: a ← a + 0fh
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
add a, M	Add data in memory with ACC, then put result into ACC
	Example: add a, MEM;
	Result: a ← a + MEM
	Affected flags: "Y Z "Y C "Y AC "Y OV
add M, a	Add data in memory with ACC, then put result into memory
	Example: add MEM, a;
	Result: MEM ← a + MEM
	Affected flags: "Y Z "Y C "Y AC "Y OV
addc a, M	Add data in memory with ACC and carry bit, then put result into ACC
	Example: addc a, MEM;
	Result: a ← a + MEM + C
	Affected flags: "Y Z "Y C "Y AC "Y OV
addc M, a	Add data in memory with ACC and carry bit, then put result into memory
	Example: addc MEM, a;
	Result: MEM ← a + MEM + C
	Affected flags: "Y Z "Y C "Y AC "Y OV
addc a	Add carry with ACC, then put result into ACC
	Example: addc a;
	Result: $a \leftarrow a + C$
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
addc M	Add carry with memory, then put result into memory
	Example: addc MEM;
	Result: MEM ← MEM + C
	Affected flags: "Y Z "Y C "Y AC "Y OV
sub a, I	Subtraction immediate data from ACC, then put result into ACC.
	Example: sub a, 0x0f;
	Result: $a \leftarrow a - 0$ fh ($a + [2$'s complement of 0fh])
sub a M	Affected flags: "Y Z "Y C "Y AC "Y OV
sub a, M	Subtraction data in memory from ACC, then put result into ACC
	Example: sub a, MEM;
	Result: $a \leftarrow a - MEM (a + [2's complement of M])$
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV

sub M, a	Subtraction data in ACC from memory, then put result into memory
	Example: sub MEM, a;
	Result: MEM ← MEM - a (MEM + [2's complement of a])
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV
subc a, M	Subtraction data in memory and carry from ACC, then put result into ACC
	Example: subc a, MEM;
	Result: a ← a – MEM - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M, a	Subtraction ACC and carry bit from memory, then put result into memory
	Example: subc MEM, a ;
	Result: MEM ← MEM – a - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc a	Subtraction carry from ACC, then put result into ACC
	Example: subc a;
	Result: a ← a - C
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV
subc M	Subtraction carry from the content of memory, then put result into memory
	Example: subc MEM;
	Result: MEM ← MEM - C
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
inc M	Increment the content of memory
	Example: inc MEM;
	Result: MEM ← MEM + 1
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
dec M	Decrement the content of memory
	Example: dec MEM;
	Result: MEM ← MEM - 1
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV
clear M	Clear the content of memory
	Example: clear MEM;
	Result: MEM ← 0
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



7.3. Shift Operation Instructions

sr a	Shift right of ACC, shift 0 to bit 7
	Example: sr a;
	Result: a (0,b7,b6,b5,b4,b3,b2,b1) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src a	Shift right of ACC with carry bit 7 to flag
	Example: src a;
	Result: a (c,b7,b6,b5,b4,b3,b2,b1) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sr M	Shift right the content of memory, shift 0 to bit 7
	Example: sr MEM;
	Result: $MEM(0,b7,b6,b5,b4,b3,b2,b1) \leftarrow MEM(b7,b6,b5,b4,b3,b2,b1,b0), C \leftarrow MEM(b0)$
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
src M	Shift right of memory with carry bit 7 to flag
	Example: src MEM;
	Result: MEM(c,b7,b6,b5,b4,b3,b2,b1) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b0)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
sl a	Shift left of ACC shift 0 to bit 0
	Example: sl a;
	Result: a (b6,b5,b4,b3,b2,b1,b0,0) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
slc a	Shift left of ACC with carry bit 0 to flag
	Example: slc a;
	Result: a (b6,b5,b4,b3,b2,b1,b0,c) ← a (b7,b6,b5,b4,b3,b2,b1,b0), C ← a(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
s/ M	Shift left of memory, shift 0 to bit 0
	Example: sl MEM;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,0) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM(b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
slc M	Shift left of memory with carry bit 0 to flag
	Example: slc MEM;
	Result: MEM (b6,b5,b4,b3,b2,b1,b0,C) ← MEM (b7,b6,b5,b4,b3,b2,b1,b0), C ← MEM (b7)
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV
swap a	Swap the high nibble and low nibble of ACC
	Example: swap a;
	Result: a (b3,b2,b1,b0,b7,b6,b5,b4) ← a (b7,b6,b5,b4,b3,b2,b1,b0)
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV



7.4. Logic Operation Instructions

	Desferred Legis AND are ACC and increasible to date their mutual soult into ACC
and a, I	Perform logic AND on ACC and immediate data, then put result into ACC
	Example: and a, 0x0f;
	Result: a ← a & 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
and a, M	Perform logic AND on ACC and memory, then put result into ACC
	Example: and a, RAM10;
	Result: a ← a & RAM10
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
and M, a	Perform logic AND on ACC and memory, then put result into memory
	Example: and MEM, a;
	Result: MEM ← a & MEM
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, I	Perform logic OR on ACC and immediate data, then put result into ACC
	Example: or a, 0x0f;
	Result: a ← a 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
or a, M	Perform logic OR on ACC and memory, then put result into ACC
	Example: or a, MEM;
	Result: a ← a MEM
	Affected flags: "Y』Z "N』C "N』AC "N』OV
or M, a	Perform logic OR on ACC and memory, then put result into memory
	Example: or MEM, a;
	Result: MEM ← a MEM
	Affected flags: "Y』Z "N』C "N』AC "N』OV
xor a, l	Perform logic XOR on ACC and immediate data, then put result into ACC
·	Example: xor a, 0x0f;
	Result: a ← a ^ 0fh
	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
xor IO, a	Perform logic XOR on ACC and IO register, then put result into IO register
,	Example: xor pa, a;
	Result: pa ← a ^ pa ; // pa is the data register of port A
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
xor a, M	Perform logic XOR on ACC and memory, then put result into ACC
	Example: xor a, MEM;
	Result: a ← a ^ RAM10
_	Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Dorform logic VOD on ACC and mamory, then put recult into mamory
xor M, a	Perform logic XOR on ACC and memory, then put result into memory
xor M, a	Example: xor MEM, a;
xor M, a	

-	
not a	Perform 1's complement (logical complement) of ACC Example: not a; Result: a ← ~a Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Application Example:
	mov a, 0x38; // ACC=0X38 not a; // ACC=0XC7
not M	Perform 1's complement (logical complement) of memory Example: not MEM; Result: MEM ← ~MEM Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Application Example:
	mov a, 0x38; mov mem, a; // mem = 0x38 not mem; // mem = 0xC7
neg a	Perform 2's complement of ACC Example: neg a; Result: a ← 〒a Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Application Example:
	mov a, 0x38; // ACC=0X38 neg a; // ACC=0XC8
neg M	Perform 2's complement of memory Example: neg MEM; Result: MEM ← 〒MEM Affected flags: 『Y』Z 『N』C 『N』AC 『N』OV
	Application Example:
	mov a, 0x38; mov mem, a; // mem = 0x38 not mem; // mem = 0xC8



7.5. Bit Operation Instructions

7.5. Bit Opera									
set0 IO.n	Set bit n of IO port to low								
	Example: set0 pa.5;								
	Result: set bit 5 of port A to low								
	Affected flags: "N』Z "N』C "N』AC "N』OV								
set1 IO.n	Set bit n of IO port to high								
	Example: set1 pa.5;								
	Result: set bit 5 of port A to high								
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV								
set0 M.n	Set bit n of memory to low								
	Example: set0 MEM.5;								
	Result: set bit 5 of MEM to low								
	Affected flags: "N』Z "N』C "N』AC "N』OV								
set1 M.n	Set bit n of memory to high								
	Example: set1 MEM.5;								
	Result: set bit 5 of MEM to high								
	Affected flags: "N_Z "N_C "N_AC "N_OV								
swapc IO.n	Swap the nth bit of IO port with carry bit								
enape rem	Example: swapc IO.0;								
	Example: swapc IO.0; Result: C ← IO.0 , IO.0 ← C								
	When IO.0 is a port to output pin, carry C will be sent to IO.0;								
	When IO.0 is a port from input pin, IO.0 will be sent to carry C;								
	Affected flags: 『N』Z 『Y』C 『N』AC 『N』OV								
	Application Example1 (serial output):								
	set1 pac.0; // set PA.0 as output								
	set0 flag.1; // C=0								
	swapc pa.0; // move C to PA.0 (bit operation), PA.0=0								
	set1 flag.1; // C=1								
	swapc pa.0; // move C to PA.0 (bit operation), PA.0=1								
	Application Example2 (serial input) :								
	set0 pac.0; // set PA.0 as input								
	swapc pa.0; // read PA.0 to C (bit operation)								
	src a; // shift C to bit 7 of ACC								
	swapc pa.0; // read PA.0 to C (bit operation)								
	src a; // shift new C to bit 7, old C								
	1								



7.6. Conditional Operation Instructions

ceqsn a, I	Compare ACC with immediate data and skip next instruction if both are equal.										
	Flag will be changed like as (a ← a - I) Example: ceqsn a, 0x55;										
	inc MEM;										
	goto error;										
	Result: If a=0x55, then "goto error"; otherwise, "inc MEM".										
	Affected flags: 『Y』Z 『Y』C 『Y』AC 『Y』OV										
ceqsn a, M	Compare ACC with memory and skip next instruction if both are equal.										
•	Flag will be changed like as (a ← a - M)										
	Example: cegsn a, MEM;										
	Result: If a=MEM, skip next instruction										
	Affected flags: "Y Z "Y C "Y AC "Y OV										
cneqsn a, M	Compare ACC with memory and skip next instruction if both are not equal.										
	Flag will be changed like as (a ← a - M)										
	Example: cneqsn a, MEM;										
	Result: If a≠MEM, skip next instruction										
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV										
cneqsn a, l	Compare ACC with immediate data and skip next instruction if both are no equal.										
	Flag will be changed like as (a ← a - I)										
	Example: cneqsn a,0x55;										
	inc MEM;										
	goto error;										
	Result: If a≠0x55, then "goto error"; Otherwise, "inc MEM".										
	Affected flags: "Y_Z "Y_C "Y_AC "Y_OV										
t0sn IO.n	Check IO bit and skip next instruction if it's low										
	Example: t0sn pa.5;										
	Result: If bit 5 of port A is low, skip next instruction										
	Affected flags: "N_Z "N_C "N_AC "N_OV										
t1sn IO.n	Check IO bit and skip next instruction if it's high										
	Example: t1sn pa.5;										
	Result: If bit 5 of port A is high, skip next instruction										
	Affected flags: "N』Z "N』C "N』AC "N』OV										
t0sn M.n	Check memory bit and skip next instruction if it's low										
	Example: t0sn MEM.5;										
	Result: If bit 5 of MEM is low, then skip next instruction										
	Affected flags: "N _x Z "N _x C "N _x AC "N _x OV										
t1sn M.n	Check memory bit and skip next instruction if it's high										
	Example: t1sn MEM.5;										
	Result: If bit 5 of MEM is high, then skip next instruction										
	Affected flags: "N_Z "N_C "N_AC "N_OV										
<i>izsn</i> a	Increment ACC and skip next instruction if ACC is zero										
.25// 4	Example: izsn a;										
	Result: $a \leftarrow a + 1$, skip next instruction if $a = 0$										
	Troodic a controlled to the trood of the control of										



dzsn a	Decrement ACC and skip next instruction if ACC is zero											
	Example: dzsn a;											
	Result: A ← A - 1,skip next instruction if a = 0											
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV											
izsn M	Increment memory and skip next instruction if memory is zero											
	Example: izsn MEM;											
	Result: MEM ← MEM + 1, skip next instruction if MEM= 0											
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV											
dzsn M	Decrement memory and skip next instruction if memory is zero											
	Example: dzsn MEM;											
	Result: MEM ← MEM - 1, skip next instruction if MEM = 0											
	Affected flags: "Y』Z "Y』C "Y』AC "Y』OV											

7.7. System control Instructions

<i>call</i> label	Function call, address can be full range address space							
	Example: call function1;							
	Result: [sp] ← pc + 1							
	pc ← function1							
	$sp \leftarrow sp + 2$							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
goto label	Go to specific address which can be full range address space							
	Example: goto error;							
	Result: Go to error and execute program.							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
ret l	Place immediate data to ACC, then return							
	Example: ret 0x55;							
	Result: A ← 55h							
	ret;							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
ret	Return to program which had function call							
	Example: ret;							
	Result: sp \leftarrow sp - 2							
	pc ← [sp]							
	Affected flags: "N_Z "N_C "N_AC "N_OV							
reti	Return to program that is interrupt service routine. After this command is executed, global							
	interrupt is enabled automatically.							
	Example: reti;							
	Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
nop	No operation							
	Example: nop;							
	Result: nothing changed							
	Affected flags: "N Z "N C "N AC "N OV							
ocadd a	Next program counter is current program counter plus ACC.							
	Example: pcadd a;							
	Result: pc ← pc + a Affected flags: 『N』Z 『N』C 『N』AC 『N』OV							
	Allected liags. TN 2 TN 2 TN 2 AC TN 2 OV							



	Application Example:
	mov a, 0x02; pcadd a; // PC <- PC+2
	goto err1; goto correct; // jump here goto err2; goto err3;
	correct: // jump here
engint	Enable global interrupt enable Example: engint; Result: Interrupt request can be sent to FPP0 Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
disgint	Disable global interrupt enable Example: disgint; Result: Interrupt request is blocked from FPP0 Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
stopsys	System halt. Example: stopsys; Result: Stop the system clocks and halt the system Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
stopexe	CPU halt. The oscillator module is still active to output clock, however, system clock is disabled to save power. Example: stopexe; Result: Stop the system clocks and keep oscillator modules active. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
reset	Reset the whole chip, its operation will be same as hardware reset. Example: reset; Result: Reset the whole chip. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV
wdreset	Reset Watchdog timer. Example: wdreset; Result: Reset Watchdog timer. Affected flags: 『N』Z 『N』C 『N』AC 『N』OV

7.8. Summary of Instructions Execution Cycle

2T		goto, call, idxm, pcadd, ret, reti
2T	Condition is fulfilled.	acres anaron toon then draw iron
1T	Condition is not fulfilled.	ceqsn, cneqsn,t0sn, t1sn, dzsn, izsn
1T		Others



7.9. Summary of affected flags by Instructions

Instruction	Z	С	AC	ov	Instruction	Z	С	AC	οv	Instruction	Ζ	С	AC	ov
mov a, I	-	-	-	-	mov M, a	-	-	-	-	mov a, M	Υ	-	-	-
mov a, IO	Υ	-	-	-	mov IO, a	_	-	-	-	<i>ldt16</i> word	-	-	-	-
stt16 word	-	-	-	-	idxm a, index	-	-	-	-	idxm index, a	-	-	-	-
xch M	-	-	-	-	pushaf	-	-	-	-	popaf	Υ	Υ	Υ	Υ
add a, I	Υ	Υ	Υ	Υ	add a, M	Υ	Υ	Υ	Υ	add M, a	Υ	Υ	Υ	Υ
addc a, M	Υ	Υ	Υ	Υ	addc M, a	Υ	Υ	Υ	Υ	addc a	Υ	Υ	Υ	Υ
addc M	Υ	Υ	Υ	Υ	sub a, I	Υ	Υ	Υ	Υ	sub a, M	Υ	Υ	Υ	Υ
sub M, a	Υ	Υ	Υ	Υ	subc a, M	Υ	Υ	Υ	Υ	subc M, a	Υ	Υ	Υ	Υ
subc a	Υ	Υ	Υ	Υ	subc M	Υ	Υ	Υ	Υ	inc M	Υ	Υ	Υ	Υ
dec M	Υ	Υ	Υ	Υ	clear M	-	-	-	-	sr a	-	Υ	-	-
src a	-	Υ	-	-	sr M	-	Υ	-	-	src M	-	Υ	-	-
s/ a	-	Υ	-	-	slc a	-	Υ	-	-	s/ M	-	Υ	-	-
slc M	-	Υ	-	-	swap a	-	-	-	-	and a, I	Υ	-	-	-
and a, M	Υ	-	-	-	and M, a	Υ	-	-	-	or a, I	Υ	ı	-	-
or a, M	Υ	-	-	-	or M, a	Υ	-	-	-	xor a, I	Υ	1	-	-
xor IO, a	-	-	-	-	xor a, M	Υ	-	-	-	xor M, a	Υ	ı	-	-
not a	Υ	-	-	-	not M	Υ	-	-	-	neg a	Υ	-	-	-
neg M	Υ	-	-	-	set0 IO.n	-	-	-	-	set1 IO.n	-	ı	-	-
set0 M.n	-	-	-	-	set1 M.n	-	-	-	-	ceqsn a, l	Υ	Υ	Υ	Υ
ceqsn a, M	Υ	Υ	Υ	Υ	t0sn IO.n	-	-	-	-	t1sn IO.n	-	1	-	-
t0sn M.n	-	-	-	-	<i>t1sn</i> M.n	-	-	-	-	izsn a	Υ	Υ	Υ	Υ
dzsn a	Υ	Υ	Υ	Υ	izsn M	Υ	Υ	Υ	Υ	dzsn M	Υ	Υ	Υ	Υ
call label	-	-	-	-	goto label	-	-	-	-	ret I	-	1	-	-
ret	-	-	-	-	reti	-	-	-	-	пор	-	1	-	-
pcadd a	-	-	-	-	engint	-	-	-	-	disgint	-	-	-	-
stopsys	-	-	-	-	stopexe	-	-	-	-	reset	-	ı	-	-
wdreset	-	ı	-	-	swapc IO.n	-	Υ	-	-	cneqsn a, l	Υ	Υ	Υ	Υ
cneqsn a, M	Υ	Υ	Υ	Υ										

7.10. BIT definition

Bit access of RAM is only available for address from 0x00 to 0x3F.



8. Code Options

Option	Selection	Description	
Security	Enable	Security Enable	
	Disable	Security Disable	
LVR	4.0V	Select LVR = 4.0V	
	3.5V	Select LVR = 3.5V	
	3.0V	Select LVR = 3.0V	
	2.75V	Select LVR = 2.75V	
	2.5V	Select LVR = 2.5V	
	2.2V	Select LVR = 2.2V	
	2.0V	Select LVR = 2.0V	
	1.8V	Select LVR = 1.8V	
Boot-up_Time	Slow	Slow: 47mS@5V	
	Fast	Fast: 780uS@5V	
Drive	Low	IO Low driving and sinking current	
	Normal	IO Normal driving and sinking current	
LCD2 (please refer to MISC.4)	Disable	VDD/2 bias voltage generator disabled, PB0 PA[0,3,4] are normal IO pins	
	PB0_A034	VDD/2 bias voltage generator enabled, PB0 PA[0,3,4] are VDD/2 if input mode	
Comparator_Edge	All_Edge	The comparator will trigger an interrupt on the rising edge or falling edge	
	Rising_Edge	The comparator will trigger an interrupt on the rising edge	
	Falling_Edge	The comparator will trigger an interrupt on the falling edge	



9. Special Notes

This chapter is to remind user who use PFS154 series IC in order to avoid frequent errors upon operation.

9.1. Warning

User must read all application notes of the IC by detail before using it. Please download the related application notes from the following link:

http://www.padauk.com.tw/tw/technical/index.aspx

9.2. Using IC

9.2.1 IO pin usage and setting

- (1) IO pin is set to be digital input
 - ♦ When IO is set as digital input, the level of Vih and Vil would changes with the voltage and temperature. Please follow the minimum value of Vih and the maximum value of Vil.
 - ♦ The value of internal pull high resistor would also changes with the voltage, temperature and pin voltage. It is not the fixed value.
- (2) If IO pin is set to be digital input and enable wake-up function
 - Configure IO pin as input
 - ◆ Set corresponding bit to "1" in PXDIER
 - ◆ For those IO pins of PA that are not used, PADIER[1:2] should be set low in order to prevent them from leakage.
- (3) PA5 is set to be output pin
 - ◆ PA5 can be set to be Open-Drain output pin only, output high requires adding pull-up resistor.
- (4) PA5 is set to be PRST# input pin
 - ◆ Configure PA5 as input
 - ◆ Set CLKMD.0=1 to enable PA5 as PRST# input pin
- (5) PA5 is set to be input pin and to connect with a push button or a switch by a long wire
 - Needs to put a >10Ω resistor in between PA5 and the long wire
 - Avoid using PA5 as input in such application.
- (6) PA7 and PA6 as external crystal oscillator
 - Configure PA7 and PA6 as input
 - Disable PA7 and PA6 internal pull-up resistor
 - Configure PADIER register to set PA6 and PA7 as analog input
 - ♦ EOSCR register bit [6:5] selects corresponding crystal oscillator frequency :
 - ♦ 01 : for lower frequency, ex : 32KHz
 - ♦ 10 : for middle frequency, ex : 455KHz, 1MHz
 - ♦ 11 : for higher frequency, ex : 4MHz
 - ◆ Program EOSCR.7 =1 to enable crystal oscillator
 - ◆ Ensure EOSC working well before switching from IHRC or ILRC to EOSC



Note: Please read the PMC-APN013 carefully. According to PMC-APN013,, the crystal oscillator should be used reasonably. If the following situations happen to cause IC start-up slowly or non-startup, PADAUK Technology is not responsible for this: the quality of the user's crystal oscillator is not good, the usage conditions are unreasonable, the PCB cleaner leakage current, or the PCB layouts are unreasonable.

9.2.2 Interrupt

(1) When using the interrupt function, the procedure should be:

Step1: Set INTEN register, enable the interrupt control bit .

Step2: Clear INTRQ register.

Step3: In the main program, using ENGINT to enable CPU interrupt function.

Step4: Wait for interrupt. When interrupt occurs, enter to Interrupt Service Routine.

Step5: After the Interrupt Service Routine being executed, return to the main program.

- * Use DISGINT in the main program to disable all interrupts
- * When interrupt service routine starts, use PUSHAF instruction to save ALU and FLAG register. POPAF instruction is to restore ALU and FLAG register before RETI as below:

(2) INTEN and INTRQ have no initial values. Please set required value before enabling interrupt function.

9.2.3 System clock switching

System clock can be switched by CLKMD register. Please notice that, NEVER switch the system clock and turn off the original clock source at the same time. For example: When switching from clock A to clock B, please switch to clock B first; and after that turn off the clock A oscillator through CLKMD.

```
◆ Example : Switch system clock from ILRC to IHRC/2
```

```
CLKMD = 0x36; // switch to IHRC, ILRC can not be disabled here
```

CLKMD.2 = 0; // ILRC can be disabled at this time

♦ ERROR: Switch ILRC to IHRC and turn off ILRC simultaneously

CLKMD = 0x50; // MCU will hang

9.2.4 Watchdog

Watchdog will be inactive once ILRC is disabled.



9.2.5 TIMER16 time out

When select \$ INTEGS BIT_R (default value) and T16M counter BIT8 to generate interrupt, if T16M counts from 0, the first interrupt will occur when the counter reaches to 0x100 (BIT8 from 0 to 1) and the second interrupt will occur when the counter reaches 0x300 (BIT8 from 0 to 1). Therefore, selecting BIT8 as 1 to generate interrupt means that the interrupt occurs every 512 counts. Please notice that if T16M counter is restarted, the next interrupt will occur once Bit8 turns from 0 to 1.

If select \$ INTEGS BIT_F(BIT triggers from 1 to 0) and T16M counter BIT8 to generate interrupt, the T16M counter changes to an interrupt every 0x200/0x400/0x600/. Please pay attention to two differences with setting INTEGS methods.

9.2.6 IHRC Calibration

- (1) The IHRC frequency calibration is performed when IC is programmed by the writer.
- (2) Because the characteristic of the Epoxy Molding Compound (EMC) would some degrees affects the IHRC frequency (either for package or COB), if the calibration is done before molding process, the actual IHRC frequency after molding may be deviated or becomes out of spec. Normally, the frequency is getting slower a bit.
- (3) It usually happens in COB package or Quick Turnover Programming (QTP). And PADAUK would not take any responsibility for this situation.
- (4) Users can make some compensatory adjustments according to their own experiences. For example, users can set IHRC frequency to be 0.5% ~ 1% higher and aim to get better re-targeting after molding.

9.2.7 LVR

User can set *MISC.2* as "1" to disable LVR. However, V_{DD} must be kept as exceeding the lowest working voltage of chip; Otherwise IC may work abnormally.



9.2.8 **Program writing**

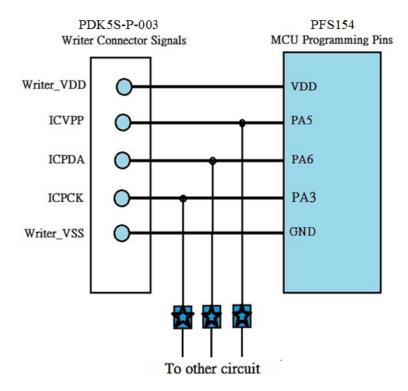
Please use PDK5S-P-003 to program. PDK3S-P-002 or older versions do not support programming PFS154.

Offline Programming

Please follow the instruction inside the writer software to connect the jumper.

Online Programming

PFS154 is allowed to online programming. 5 wires PDK5S-P-003 are used for programming: ICPCK (clock), ICPDA (data), V_{DD}, GND and ICVPP (programming high voltage), are used to connect PA3, PA6, V_{DD}, GND and PA5 respectively.



The above figure shows the connection for PFS154 online programming. In this figure, ☆ can probably be resistors or capacitors and are used to separate from the peripheral circuit. Their conditions are as the following table:

PFS154 pin	resistor	capacitor
V _{DD} / GND		≦0.1uF
PA3 / PA5 / PA6	≧10KΩ	≦220pF

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At the same time, please set the O/S test only on these selected pins according to the Section 5.5 in "Writer PDK5S-P-003 UM" file.



Warning:

- (1) The voltage of PA5 during online programming may be as high as 8V. So, please be sure that the peripheral circuit can withstand in such high voltage without damage.
- (2) The voltage of other pins may be above 5.5V.
- (3) If the COB board uses a 5.1V Zener diode to limit V_{DD} , please be sure to select "MTP On-board VDD limitation" on the writer screen (please refer to the file of "Writer PDK5S-P-003 UM"). And the highest V_{DD} is still 5.0V.
- Special notes about voltage and current while Multi-Chip-Package(MCP) or On-Board Programming (1)PA5 (V_{PP}) may be higher than 11V.
- (2)V_{DD} may be higher than 6.5V, and its maximum current may reach about 20mA.
- (3)All other signal pins level (except GND) are the same as V_{DD} .

User should confirm when using this product in MCP or On-Board Programming, the peripheral circuit or components will not be destroyed or limit the above voltages.

9.3. Using ICE

- (1) It is recommended to use PDK5S-I-S01/2(B) for emulation of PFS154.
- (2) PDK5S-I-S01/2(B) supports PFS154 1-FPPA MCU emulation work, the following items should be noted when using PDK5S-I-S01/2(B) to emulate PFS154:
 - PDK5S-I-S01/2(B) doesn't support SYSCLK=ILRC/16
- PDK5S-I-S01/2(B) doesn't support the dynamic setting of function *misc.4* (Only fix to 0 or 1)
- PDK5S-I-S01/2(B) doesn't support the output of PWMG2C.PA5
- PDK5S-I-S01/2(B) doesn't support the function *Tm2.gpcrs*/*Tm3.gpcrs*
- The PA3 output function will be affected when GPCS selects output to PA0 output.
- Fast Wakeup time is different from PDK5S-I-S01/2(B): 128 SysClk, PFS154: 45 ILRC
- Watch dog time out period is different from PDK5S-I-S01/2(B):

WDT period	PDK5S-I-S01/2 (B)	PFS154
misc[1:0]=00	2048 * T _{ILRC}	8192 * T _{ILRC}
misc[1:0]=01	4096 * T _{ILRC}	16384 * T _{ILRC}
misc[1:0]=10	16384 * T _{ILRC}	65536 * T _{ILRC}
misc[1:0]=11	256 * T _{ILRC}	262144 * T _{ILRC}